

Model Name: GA-H97M-DS3P

SHEET

TITLE

Revision 1.0

01	COVER SHEET
02	BOM & PCB MODIFY HISTORY
03	BLOCK DIAGRAM
04	CPU_LGA1150-A
05	CPU_LGA1150-B
06	CPU_LGA1150-C
07	DDR III CHANNEL A 1,2
08	DDR III CHANNEL B 1,2
09	PCH_FDI,DMI,USB,PCIE,NVRAM
10	PCH_DP,CLK BUFFER
11	PCH_HOST,SATA,PCI
12	PCH_GPIO,CTRL,AUDIO
13	PCH_PWR,GND
14	PCI EXPRESS*16 SLOT
15	PCI, PCI EXPRESS X1 *2 SLOT
16	ITE 8620 LPC IO
17	COM,KB_MS_USB,USB30_20
18	HWM,FAN CTRL,OV,-PROCHOT
19	DUAL BIOS
20	FP,FUSB,SPK,SATALED
21	Realtek ALC887-VD2
22	REAR AUDIO JACK
23	INTEL I217V
24	DISCRETE POWER
25	ATX
26	VCORE ISL95820_1
27	VCORE ISL95820_2

www.xinxunwei.com 400-800-9990

SHEET

TITLE

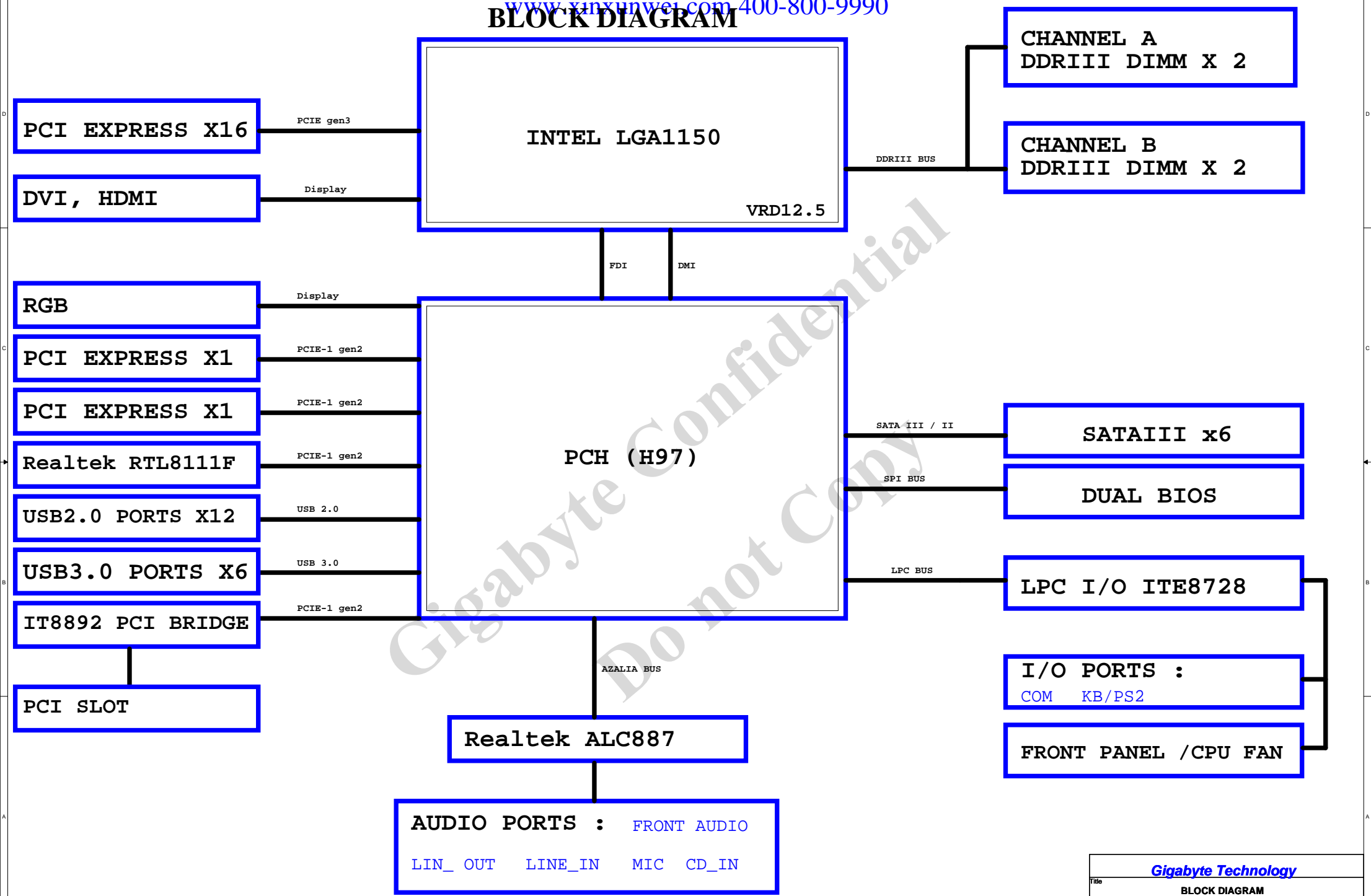
28	RT8120_DDR POWER
29	LPT, M3 POWER
30	DVI, HDMI
31	IT8892 PCI BRIDGE

Gigabyte Technology

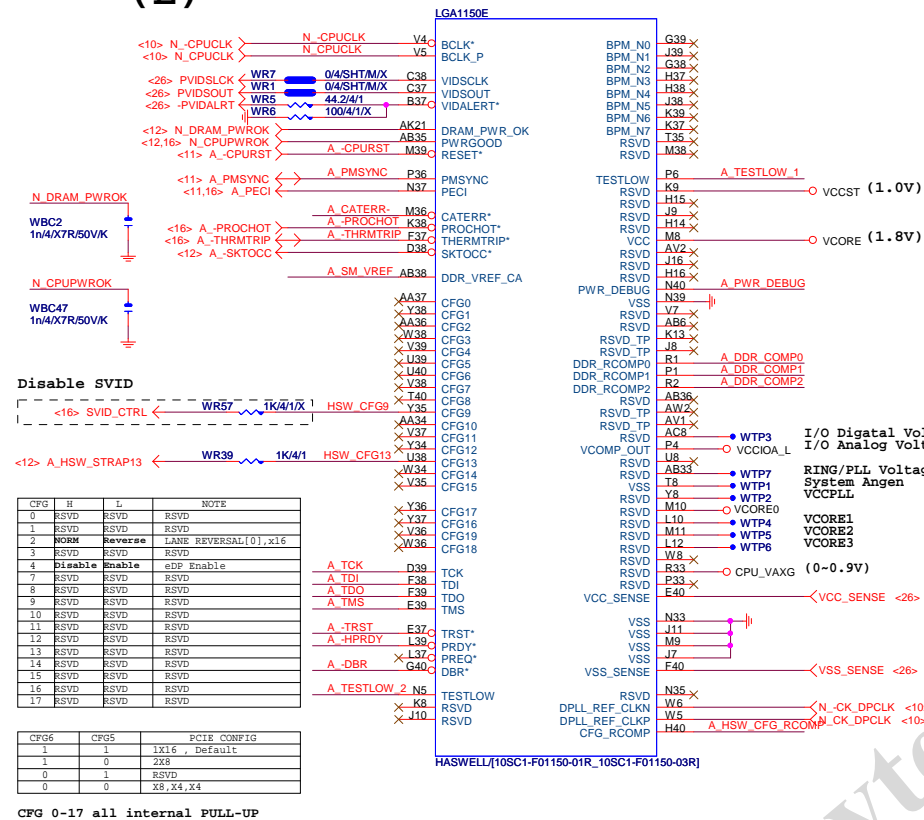
Title			
Cover Sheet			
Size	Document Number	GA-H97M-DS3P	Rev
Custom			1.0
Date:	Tuesday, April 22, 2014	Sheet	1 of 31

[illegible][illegible][illegible][illegible][illegible][illegible][illegible]

BLOCK DIAGRAM



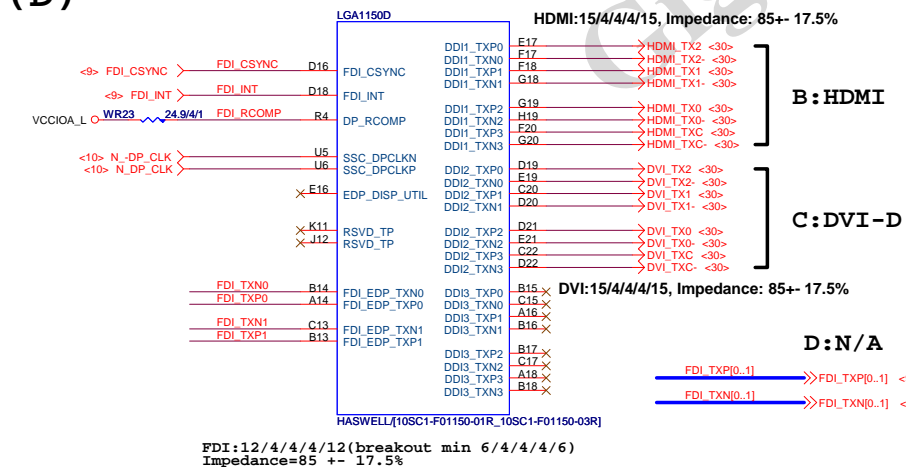
LGA1150 (E)



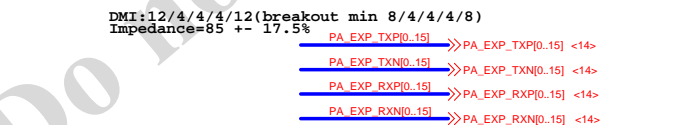
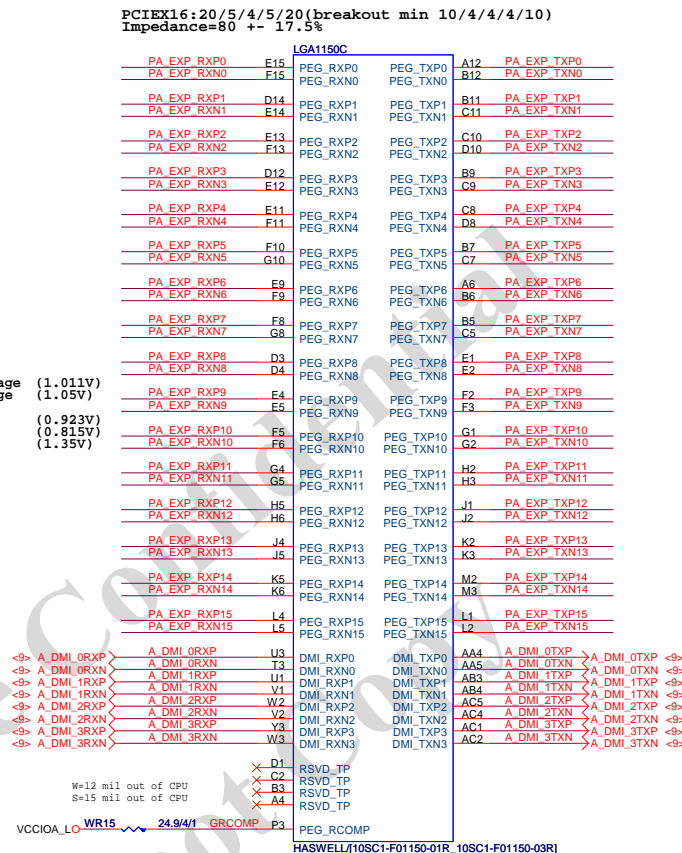
LGA1150

(D)

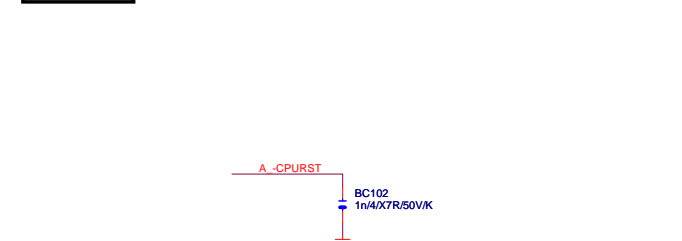
DVI-I + HDMI組態就是: DVI-I port B, HDMI port C
DVI-D + HDMI組態就是: DVI-D port C, HDMI port B



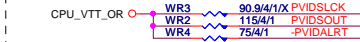
LGA1155 (C)



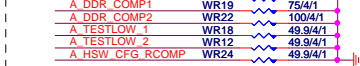
-CPURST



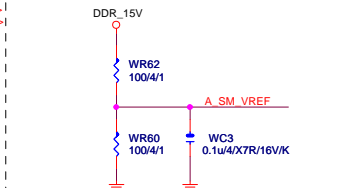
CPU SVID

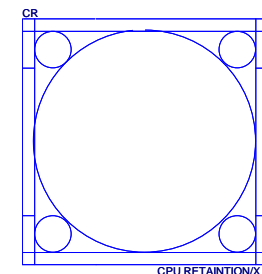


CPU PU/PD



SM REF

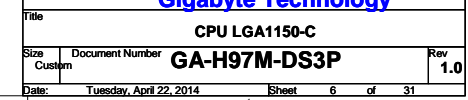


**LGA1150**

ILM_BP/1156/CSP/ILM_BP/1156/CSP/12KRC-0F0001-52R_12KRC-0F0001-51R

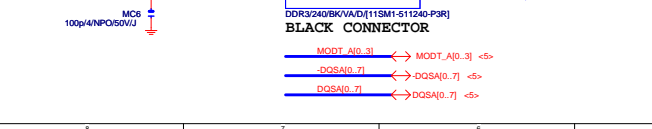
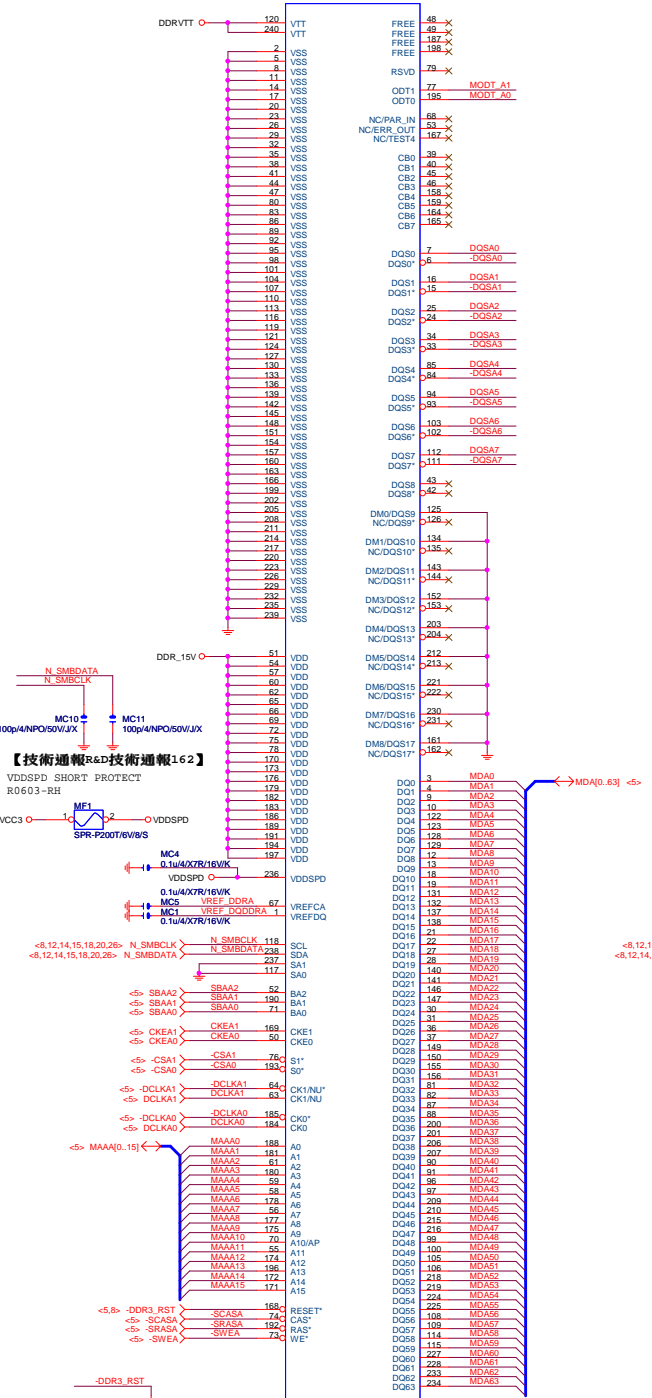
DDR BUS

<7>	MODT_A[0..3]	↔	MODT_A[0..3]
<8>	MODT_B[0..3]	↔	MODT_B[0..3]
<7>	MDA[0..63]	↔	MDA[0..63]
<8>	MDB[0..63]	↔	MDB[0..63]
<7>	DQSA[0..7]	↔	DQSA[0..7]
<7>	-DQSA[0..7]	↔	-DQSA[0..7]
<7>	MAAA[0..15]	↔	MAAA[0..15]
<8>	MAAB[0..15]	↔	MAAB[0..15]
<8>	DQSB[0..7]	↔	DQSB[0..7]
<8>	-DQSB[0..7]	↔	-DQSB[0..7]



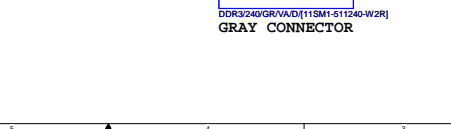
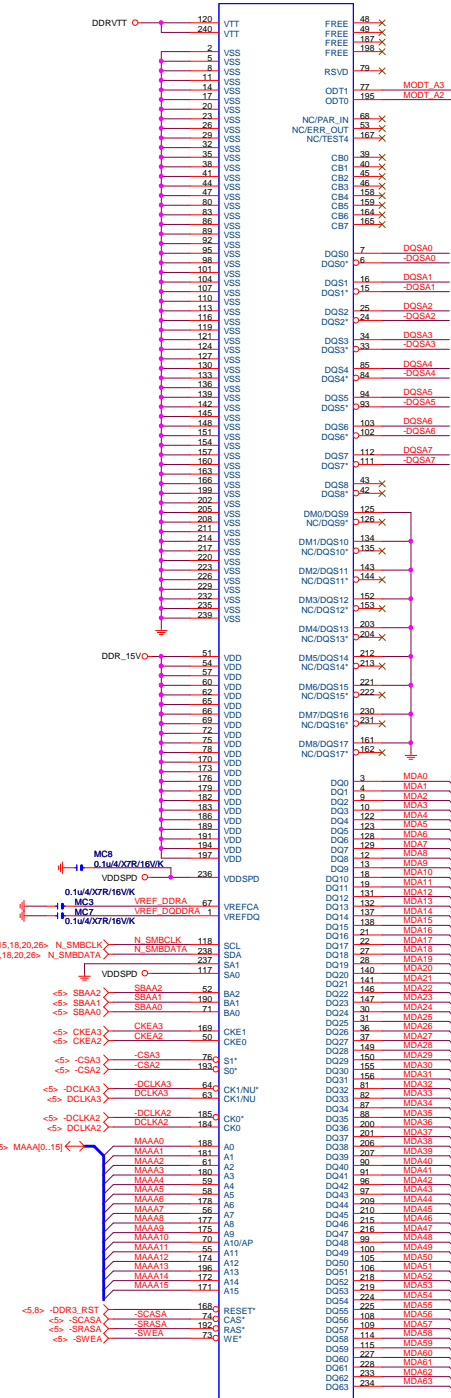
DDR3

(A)

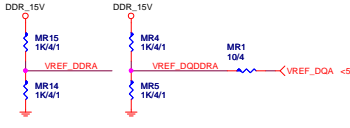


DDR3

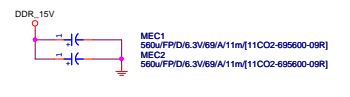
www.xinxunwei.com 400-880-9990



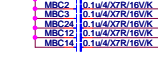
DDR3_VREF



DDR15V Decouple



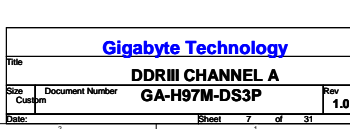
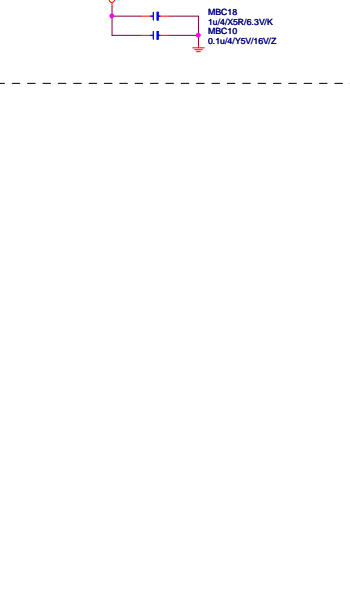
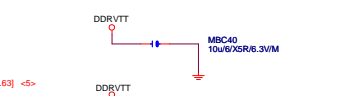
DDR15V



DDR15V



DDRVTT Decouple



Gigabyte Technology

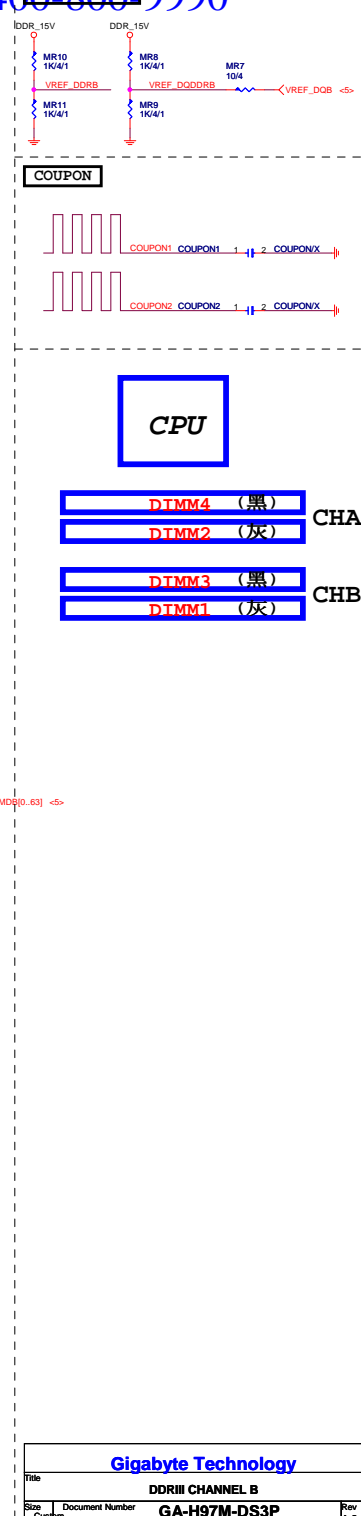
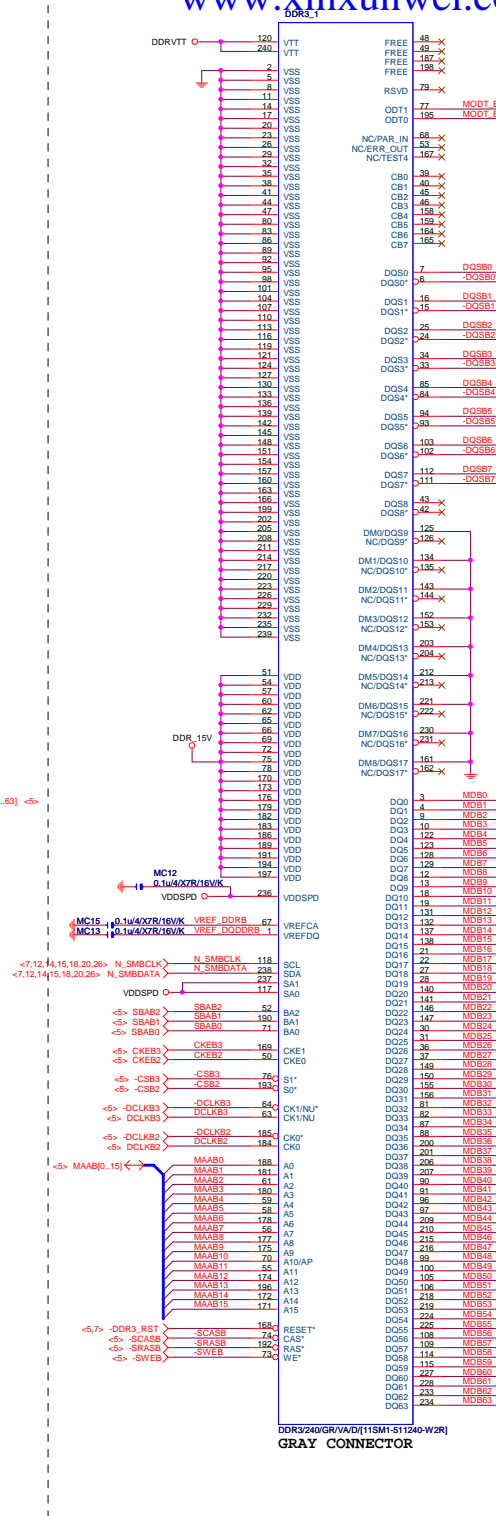
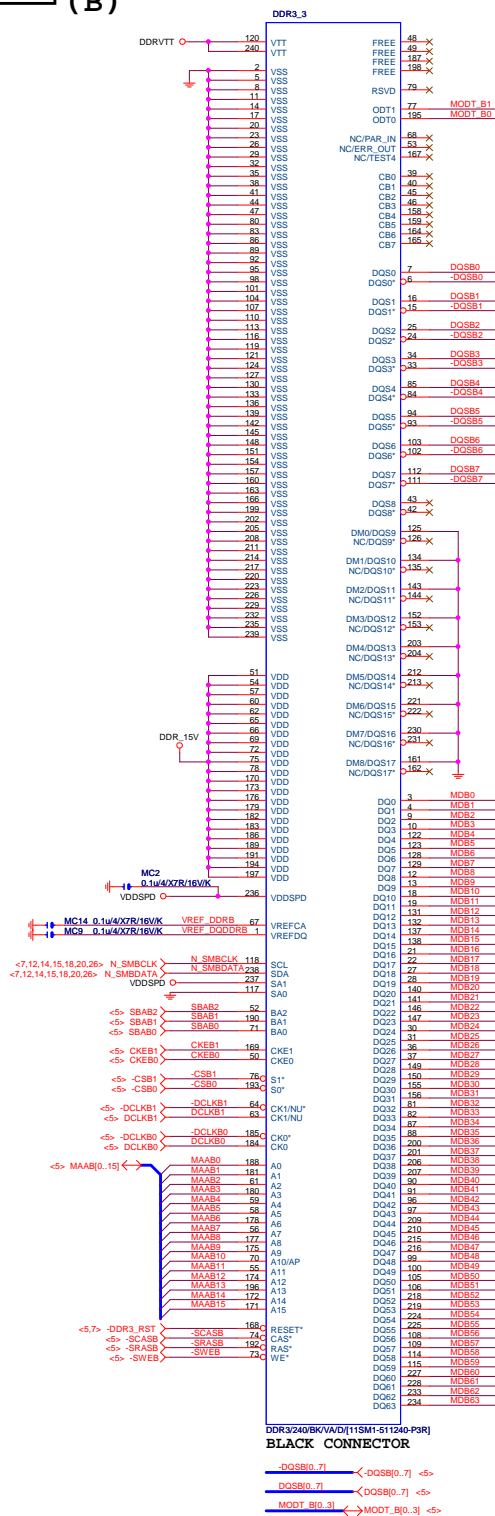
DDRIII CHANNEL A

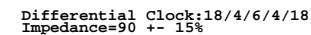
GA-H97M-DS3P

Rev 1.0

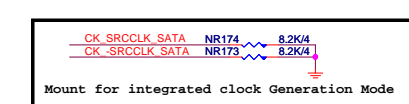
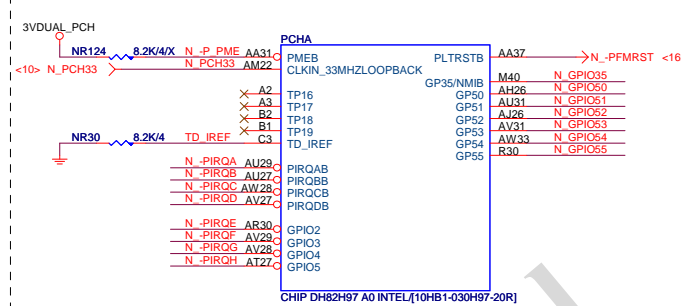
Sheet 7 of 31

(B)

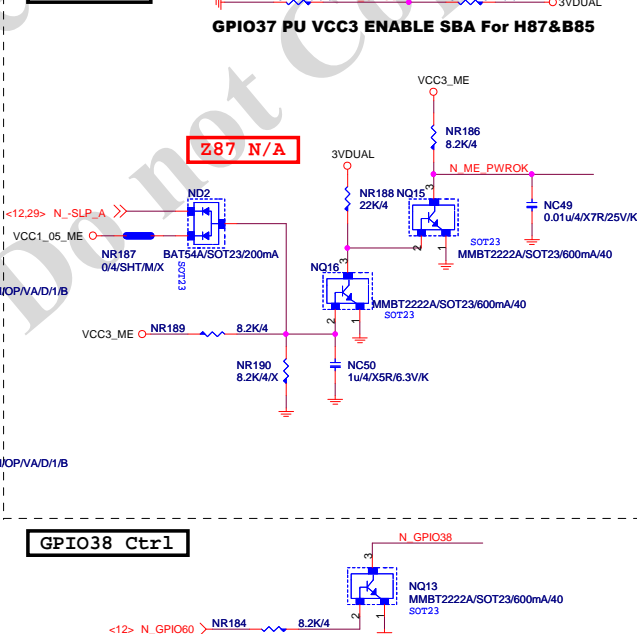




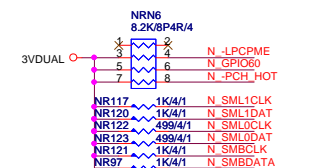
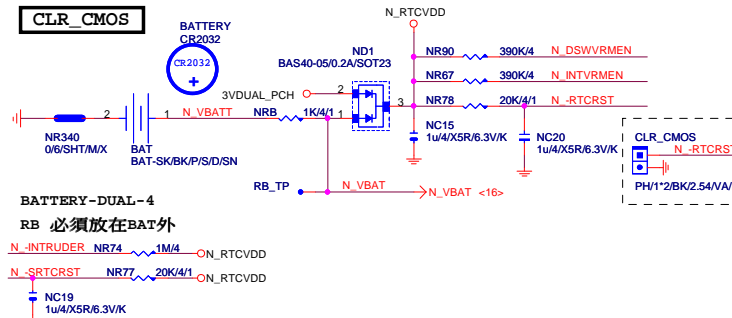
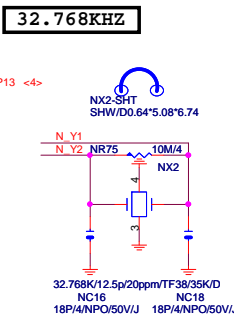
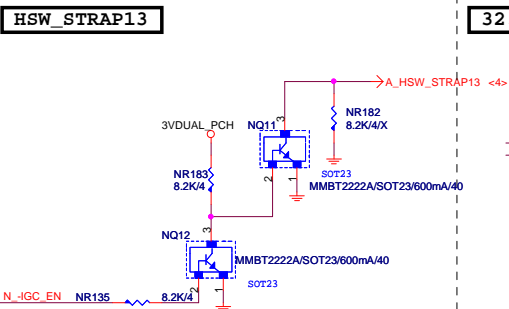
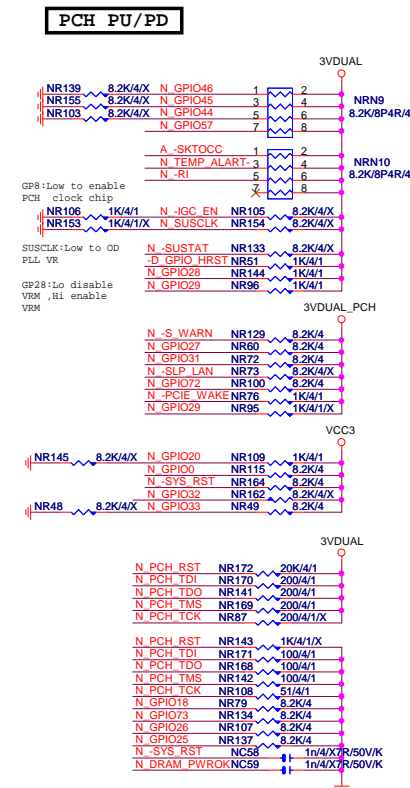
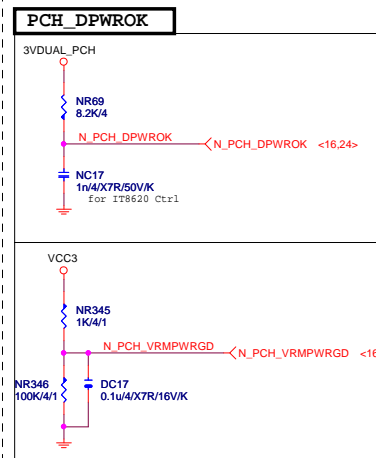
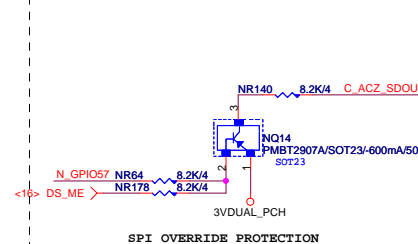
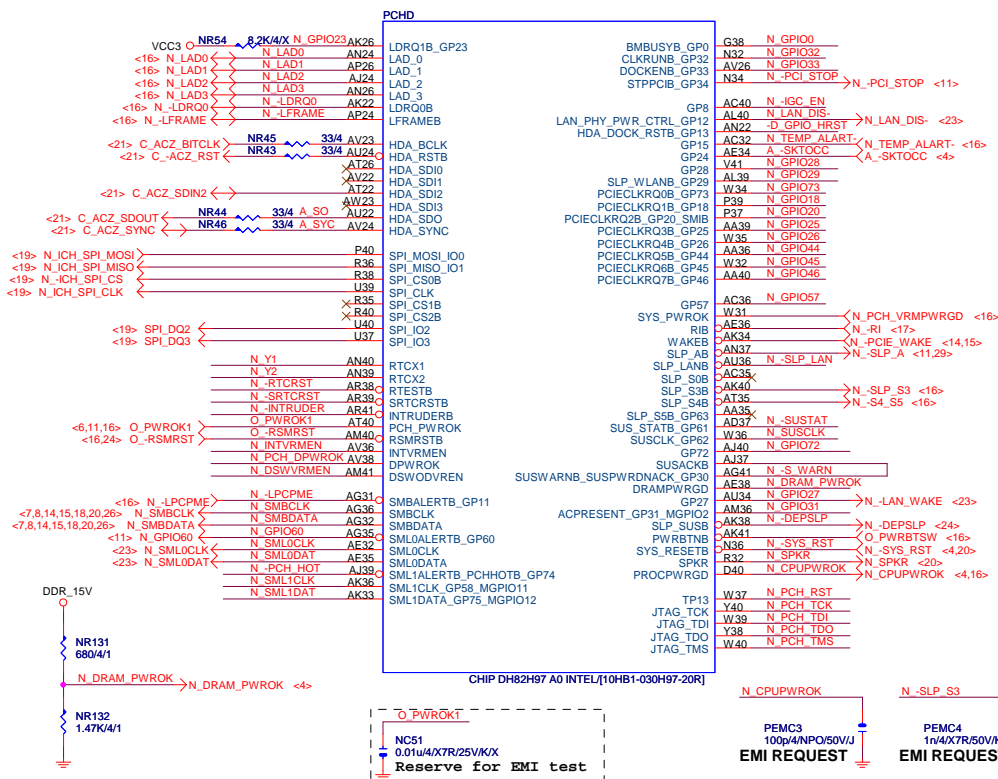
PCH (A)

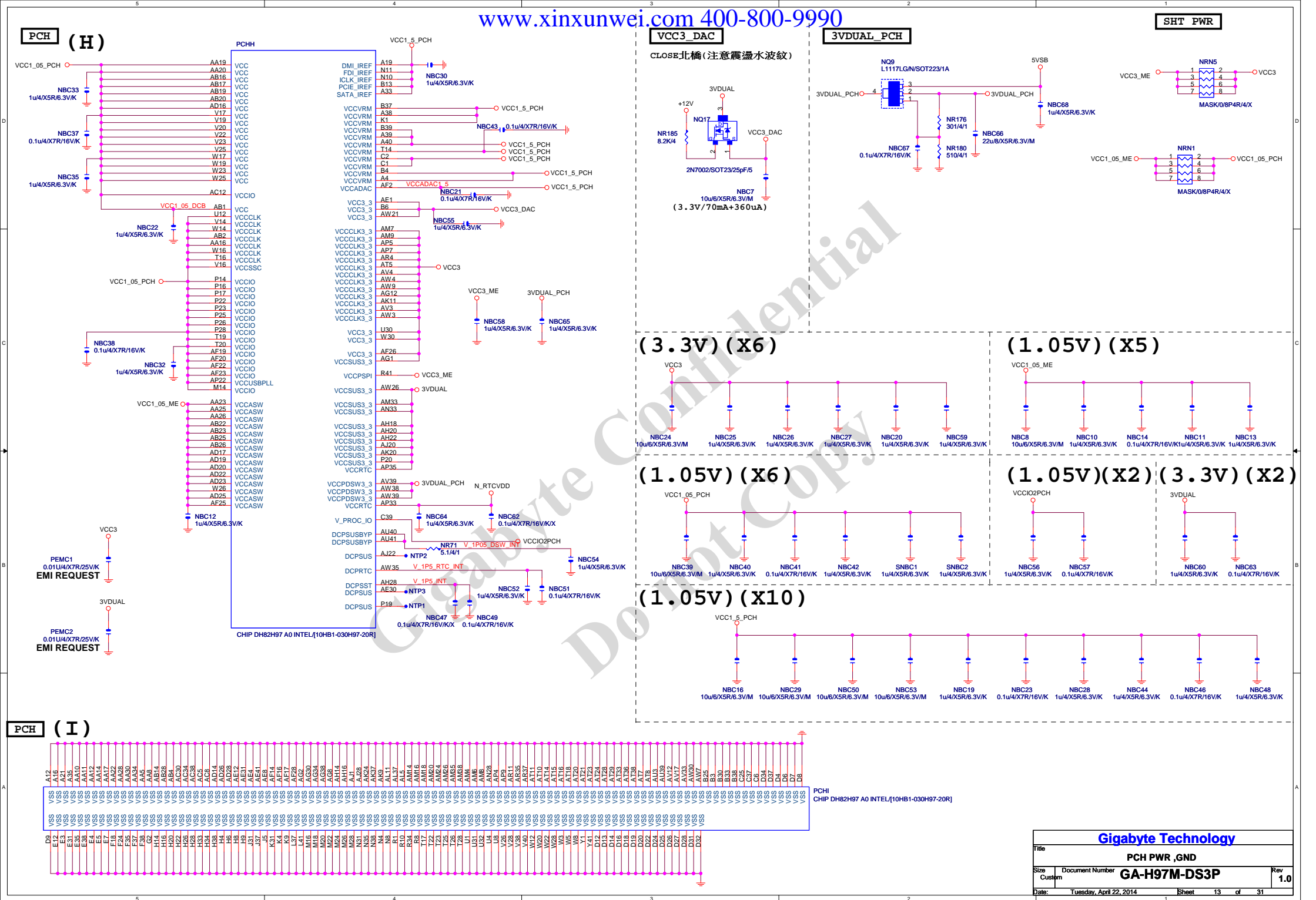


ME PWROK

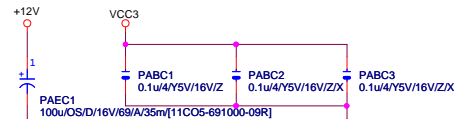


GPIO38 Ctrl

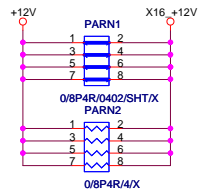




PCIEX16 CAP



PCIEX16 PROTECT SHT



PCIEX16 AC CAP

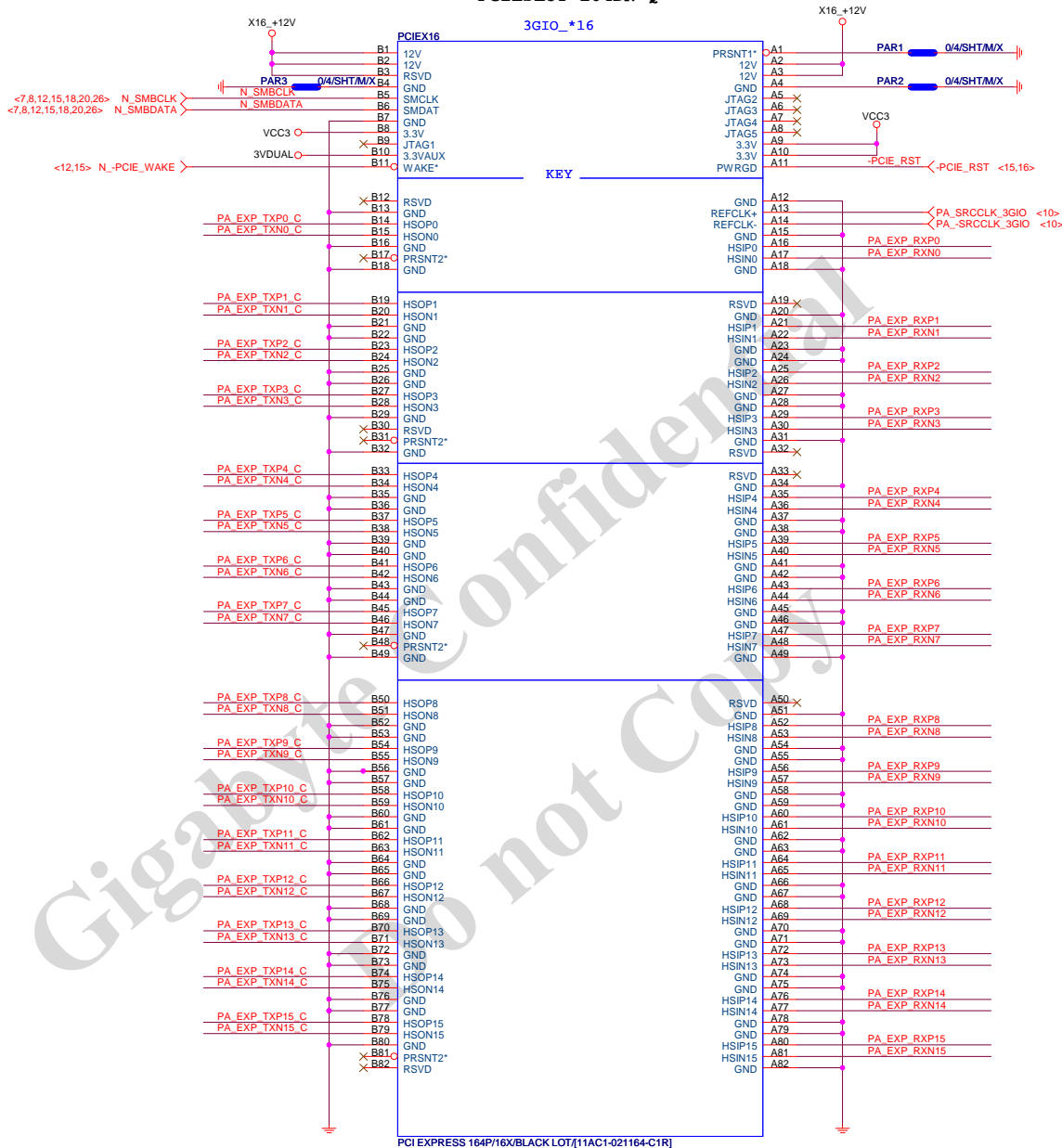
PA EXP TXP0	PAC5	0.22u/4/X5R6.3V/K	PA EXP TXP0 C
PA EXP TXN0	PAC4	0.22u/4/X5R6.3V/K	PA EXP TXN0 C
PA EXP TXP1	PAC6	0.22u/4/X5R6.3V/K	PA EXP TXP1 C
PA EXP TXN1	PAC7	0.22u/4/X5R6.3V/K	PA EXP TXN1 C
PA EXP TXP2	PAC8	0.22u/4/X5R6.3V/K	PA EXP TXP2 C
PA EXP TXN2	PAC9	0.22u/4/X5R6.3V/K	PA EXP TXN2 C
PA EXP TXP3	PAC10	0.22u/4/X5R6.3V/K	PA EXP TXP3 C
PA EXP TXN3	PAC11	0.22u/4/X5R6.3V/K	PA EXP TXN3 C
PA EXP TXP4	PAC12	0.22u/4/X5R6.3V/K	PA EXP TXP4 C
PA EXP TXN4	PAC13	0.22u/4/X5R6.3V/K	PA EXP TXN4 C
PA EXP TXP5	PAC14	0.22u/4/X5R6.3V/K	PA EXP TXP5 C
PA EXP TXN5	PAC15	0.22u/4/X5R6.3V/K	PA EXP TXN5 C
PA EXP TXP6	PAC16	0.22u/4/X5R6.3V/K	PA EXP TXP6 C
PA EXP TXN6	PAC17	0.22u/4/X5R6.3V/K	PA EXP TXN6 C
PA EXP TXP7	PAC19	0.22u/4/X5R6.3V/K	PA EXP TXP7 C
PA EXP TXN7	PAC18	0.22u/4/X5R6.3V/K	PA EXP TXN7 C
PA EXP TXP8	PAC20	0.22u/4/X5R6.3V/K	PA EXP TXP8 C
PA EXP TXN8	PAC21	0.22u/4/X5R6.3V/K	PA EXP TXN8 C
PA EXP TXP9	PAC22	0.22u/4/X5R6.3V/K	PA EXP TXP9 C
PA EXP TXN9	PAC23	0.22u/4/X5R6.3V/K	PA EXP TXN9 C
PA EXP TXP10	PAC24	0.22u/4/X5R6.3V/K	PA EXP TXP10 C
PA EXP TXN10	PAC25	0.22u/4/X5R6.3V/K	PA EXP TXN10 C
PA EXP TXP11	PAC26	0.22u/4/X5R6.3V/K	PA EXP TXP11 C
PA EXP TXN11	PAC27	0.22u/4/X5R6.3V/K	PA EXP TXN11 C
PA EXP TXP12	PAC28	0.22u/4/X5R6.3V/K	PA EXP TXP12 C
PA EXP TXN12	PAC29	0.22u/4/X5R6.3V/K	PA EXP TXN12 C
PA EXP TXP13	PAC30	0.22u/4/X5R6.3V/K	PA EXP TXP13 C
PA EXP TXN13	PAC31	0.22u/4/X5R6.3V/K	PA EXP TXN13 C
PA EXP TXP14	PAC32	0.22u/4/X5R6.3V/K	PA EXP TXP14 C
PA EXP TXN14	PAC33	0.22u/4/X5R6.3V/K	PA EXP TXN14 C
PA EXP TXP15	PAC34	0.22u/4/X5R6.3V/K	PA EXP TXP15 C
PA EXP TXN15	PAC35	0.22u/4/X5R6.3V/K	PA EXP TXN15 C

PA EXP RXP[0..15] >>>PA_EXP_RXP[0..15] <4>
PA EXP RXN[0..15] >>>PA_EXP_RXN[0..15] <4>
PA EXP TXP[0..15] >>>PA_EXP_TXP[0..15] <4>
PA EXP TXN[0..15] >>>PA_EXP_TXN[0..15] <4>

PCIEX16 SLOT

www.xinxunwei.com 400-800-9990

PCIESLOT-164DN-Q

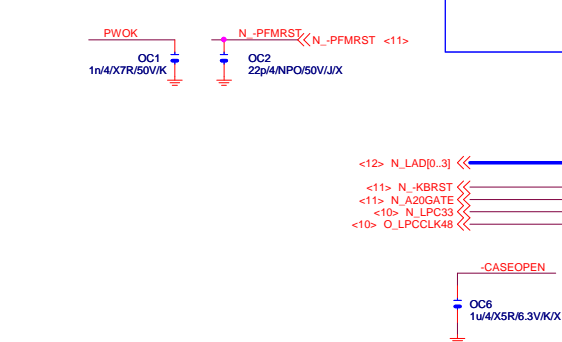
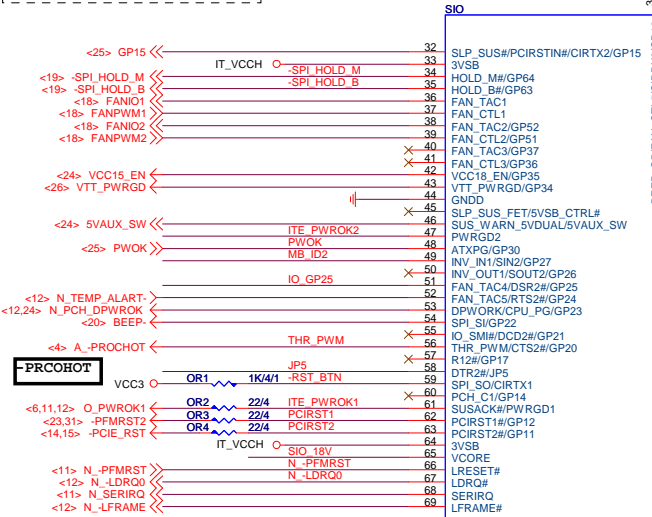
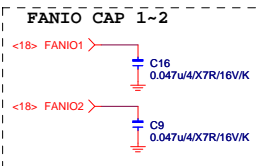


PCI EXPRESS 164P/16X/BLACK LOT[11AC1-021164-C1R]

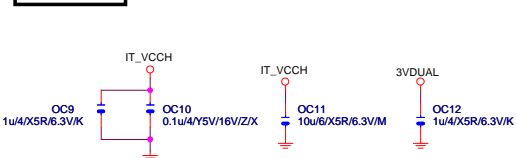
BLACK CONNECTOR

Gigabyte Technology

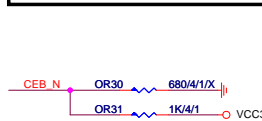
Title			PCI EXPRESS * 16
Size			GA-H97M-DS3P
Date:			Tuesday, April 22, 2014
Sheet			14 of 31



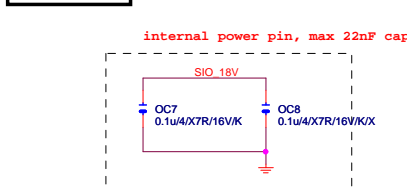
SIO CAP



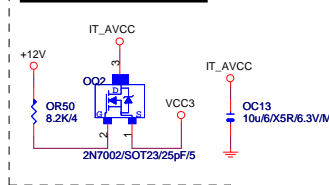
DUAL BIOS OPT STRAP



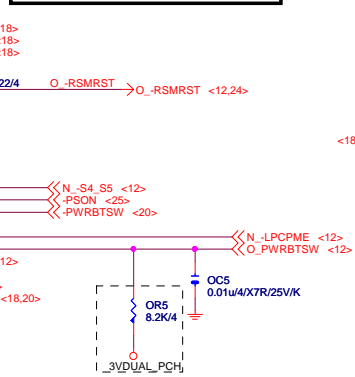
SIO_18V



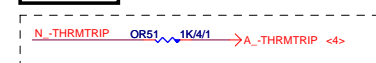
FIX ATX 插拔漏電
Power leakage



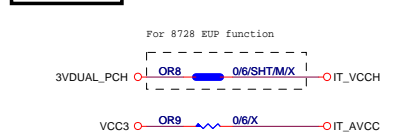
PC Health Code: C003



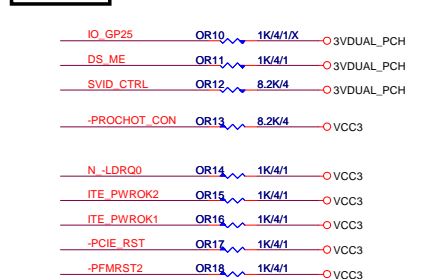
-THRMTRIP



PWR	SHT
-----	-----

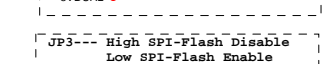
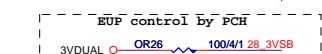
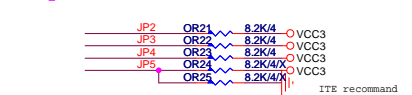


SIO PU

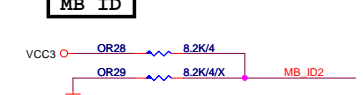


SIO STRAP

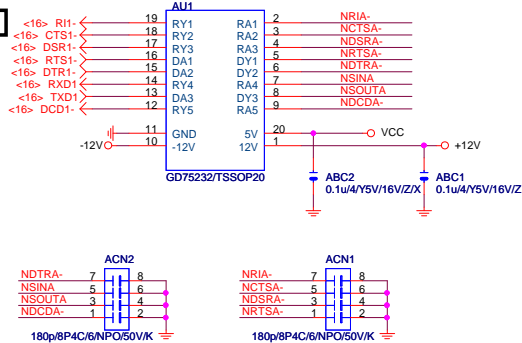
H61M-S2 1.1 JP6 stuff
pull down



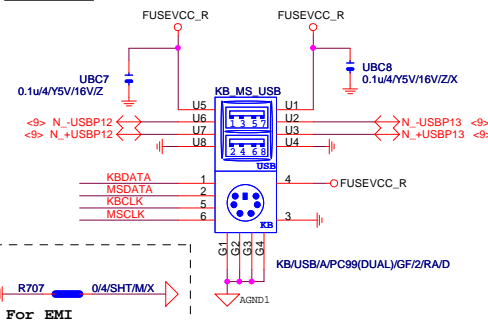
MP ID



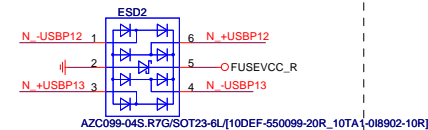
COM



KB/MS



USB2.0 ESD



USB2.0 PWR

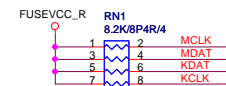
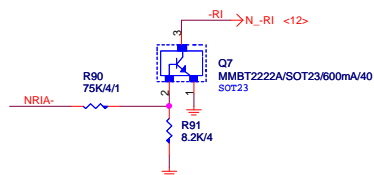
FUSE-0805



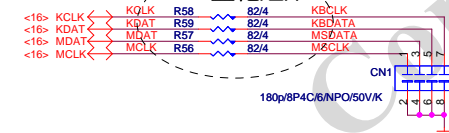
Close to connector

KB_MS_USB 2-Port 2.0A

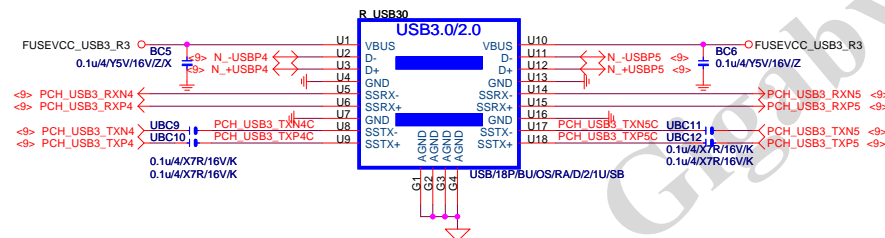
COM RI



FOR 鹽化短路

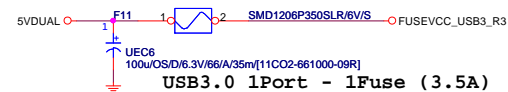


USB30_20

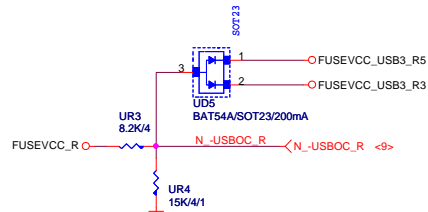


USB30_20 PWR

Polyswitch-1206

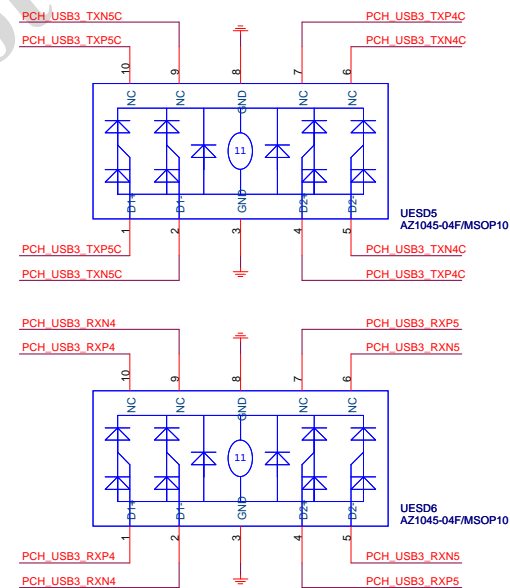


-USBOC_R

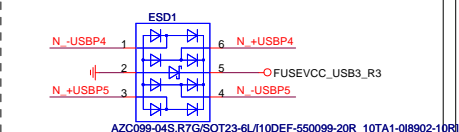


USB30_20 ESD PROTECT

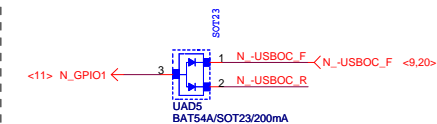
USB3.0 ESD



USB2.0 ESD

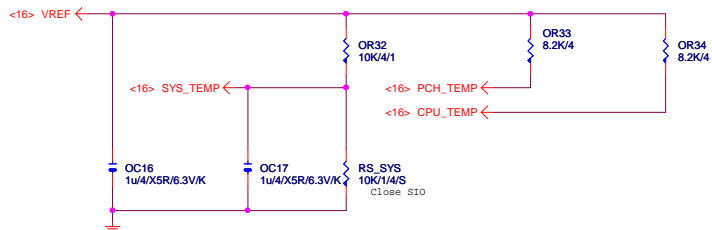


USB POWER PROTECT

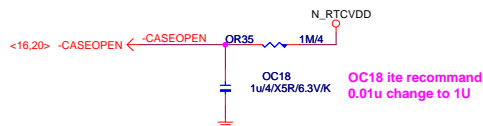


Gigabyte Technology

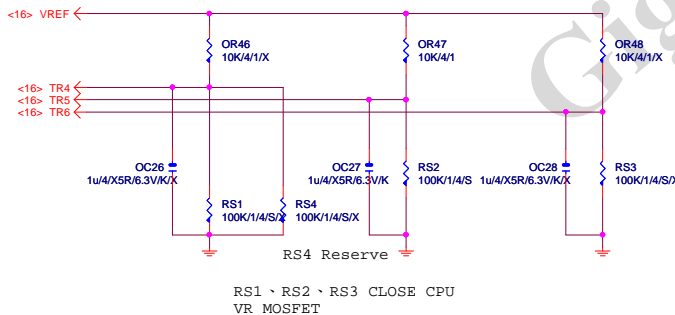
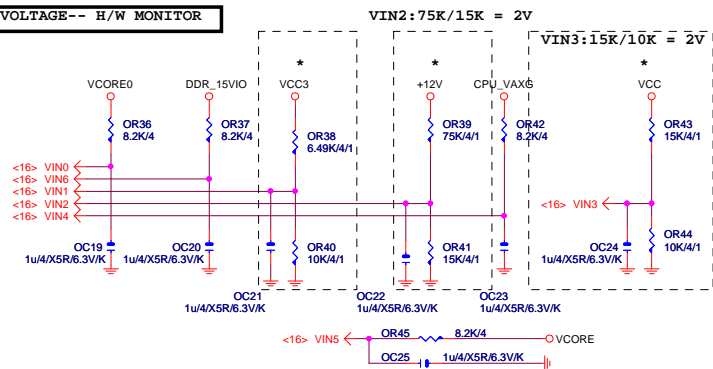
TEMP H/W MONITOR



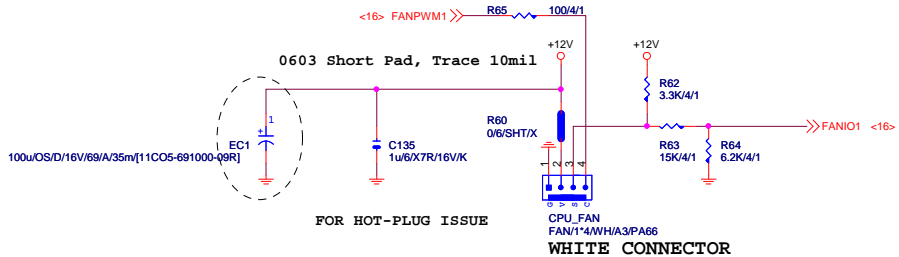
CASE OPEN



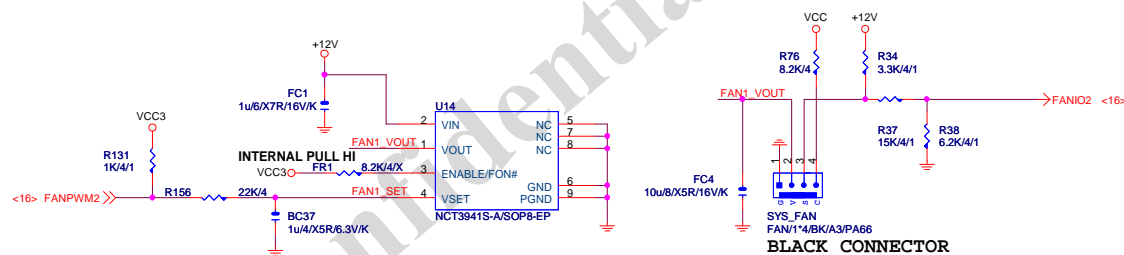
VOLTAGE-- H/W MONITOR



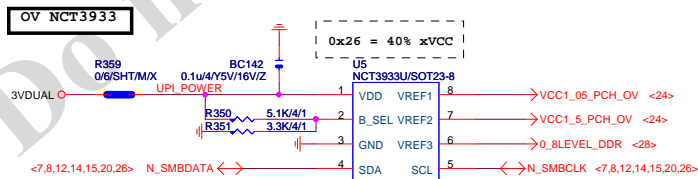
CPU SMART FAN



SYS SMART FAN

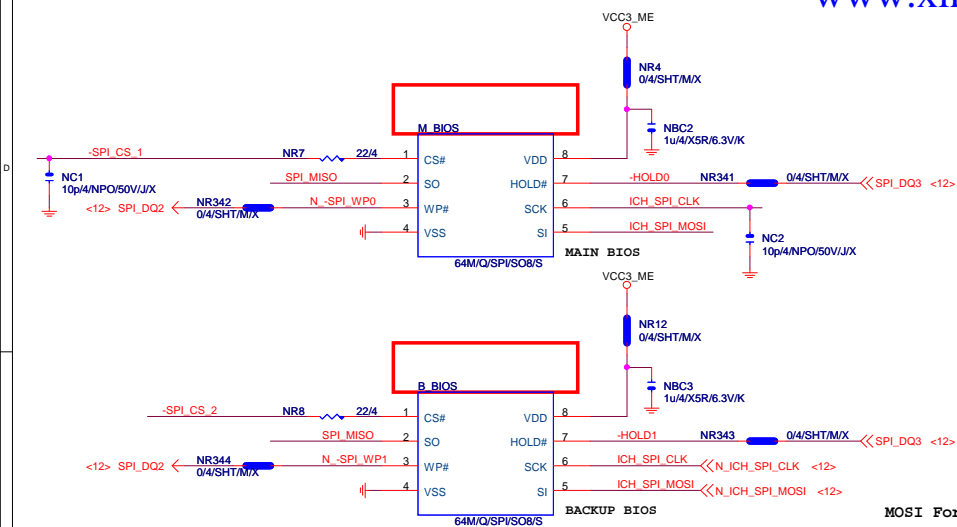


接pwm feedback pin



Gigabyte Technology

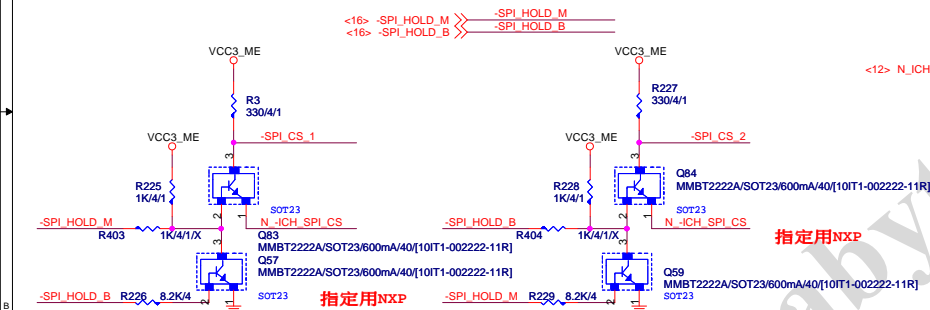
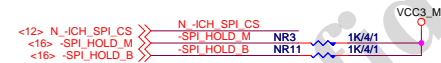
Title			
HWM,FAN CTRL,OV			
Size	Document Number	Rev	
Custom	GA-H97M-DS3P	1.0	
Date:	Tuesday, April 22, 2014	Sheet	18 of 31



BOOT DEVICE	GNT0	GNT1
LPC	0	0
PCI	0	1
NAND	1	0
SPI	1	1

1 means floating,
0 means PD 1K

MOSI For DMI RX Termination Voltage



指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

指定用NXP

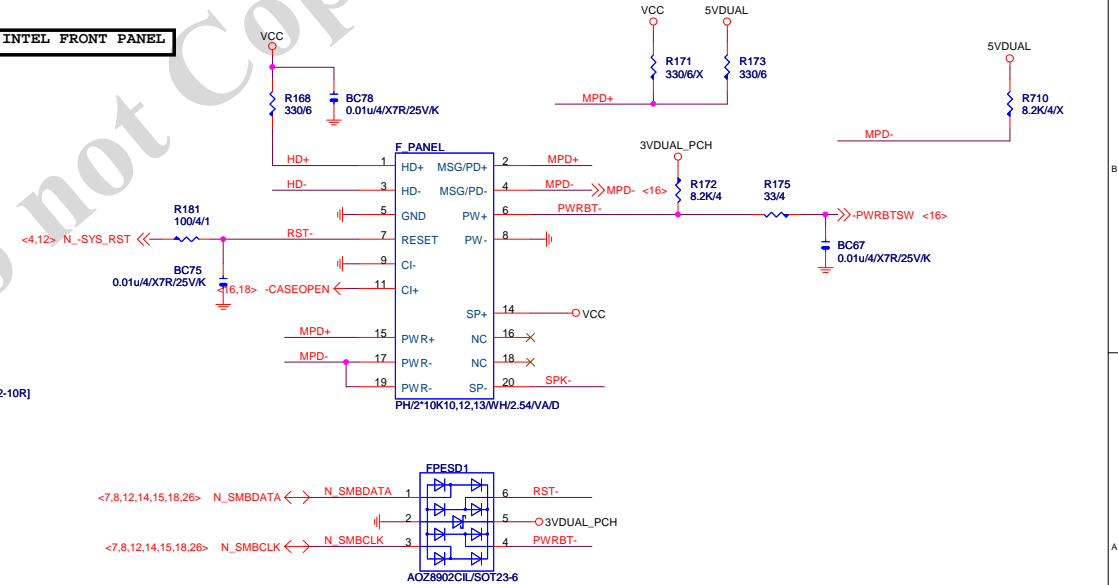
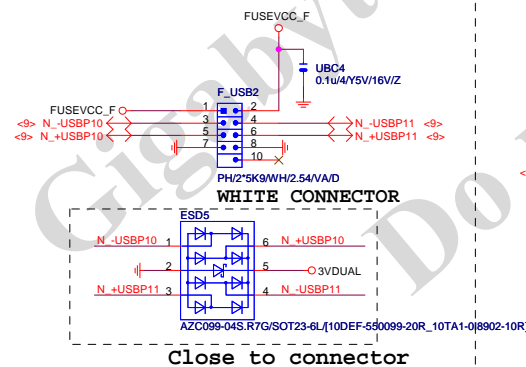
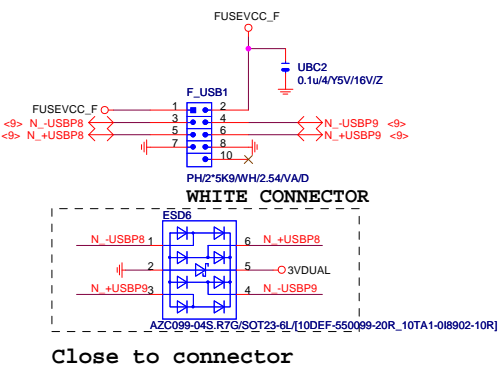
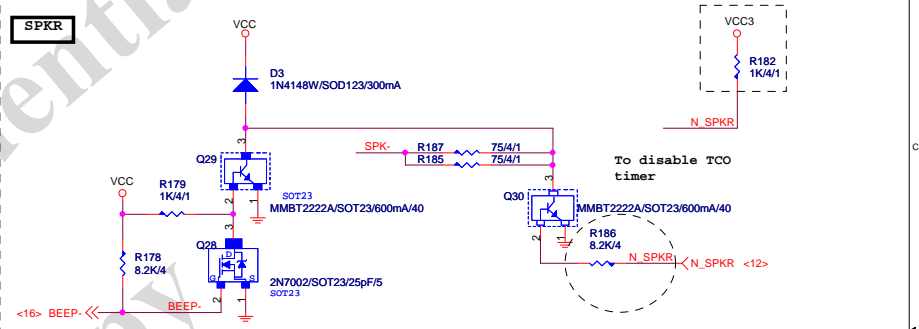
指定用NXP

指定用NXP

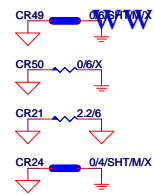
指定用NXP

指定用NXP

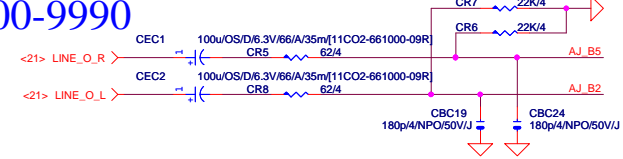
指定用NXP



Schematic diagram of the FUSEVCC_F power supply circuit. It shows a 100µF electrolytic capacitor (UEC1) connected to a 6.3V/66A/35mV diode (F4) in series with a 100nF ceramic capacitor (C1). The output is connected to the FUSEVCC_F pin.



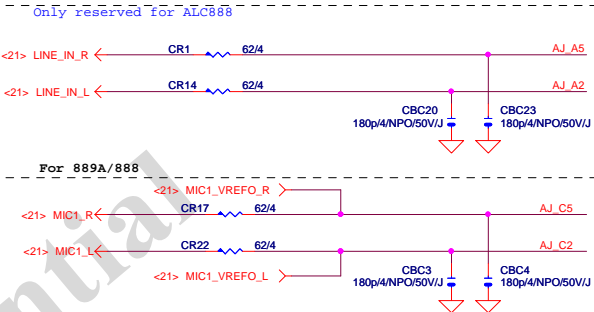
LINE-OUT



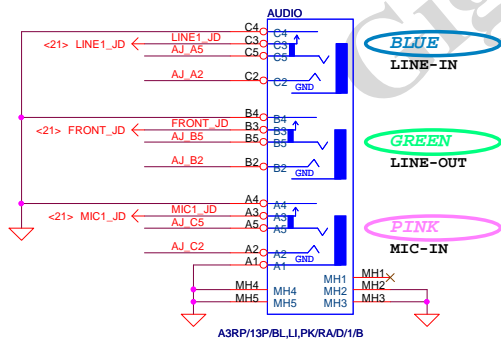
LINE-IN

Verify MIC function
in LINE-in

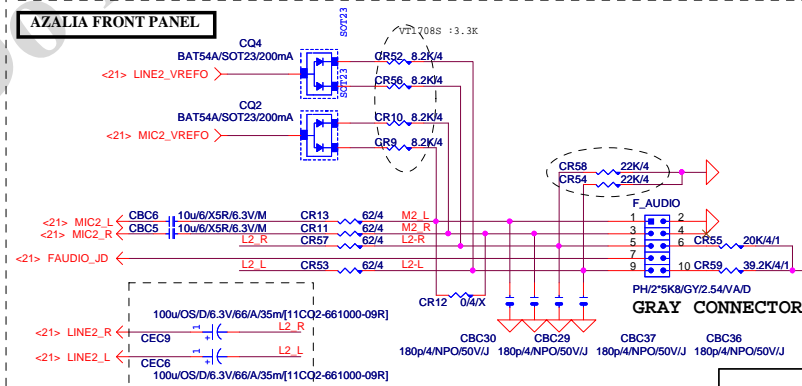
MIC-IN



SPDIF_OUT

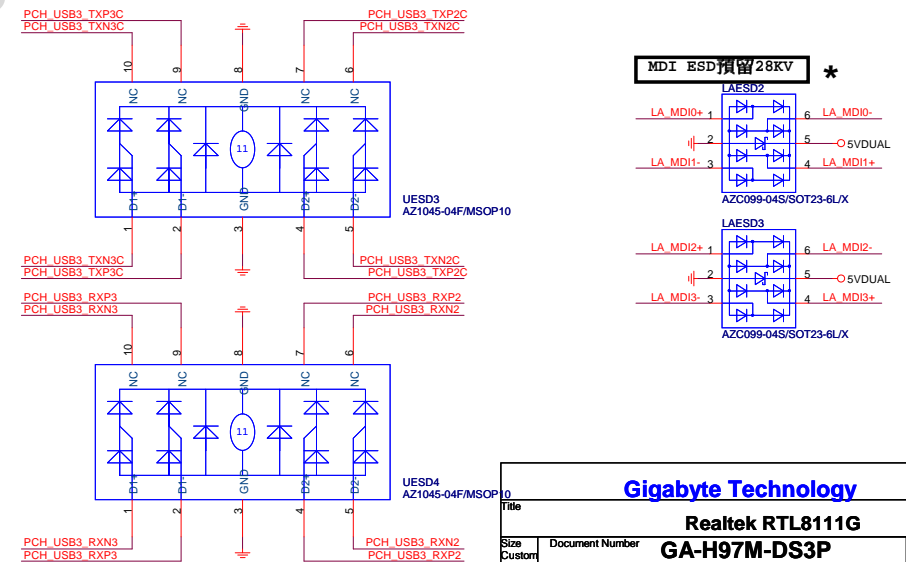
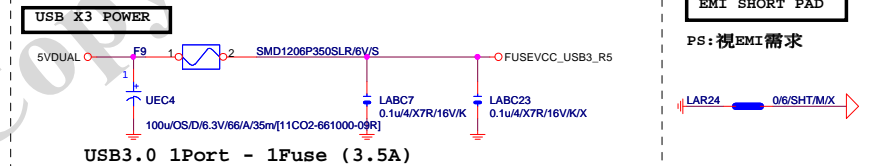
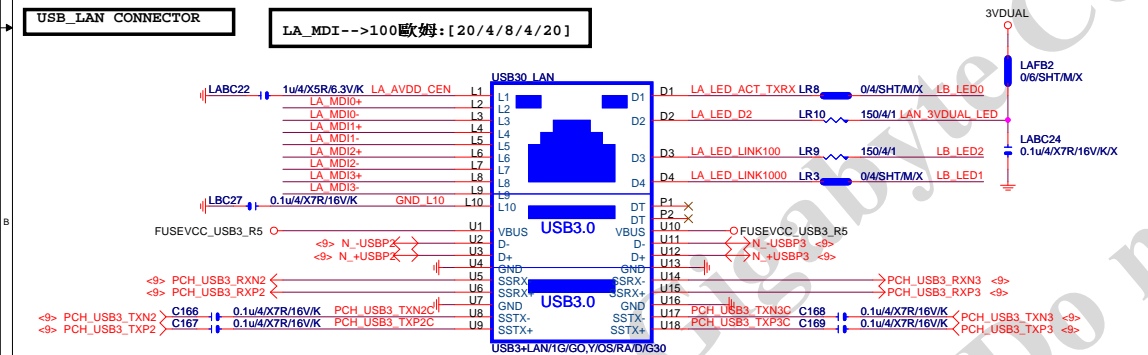
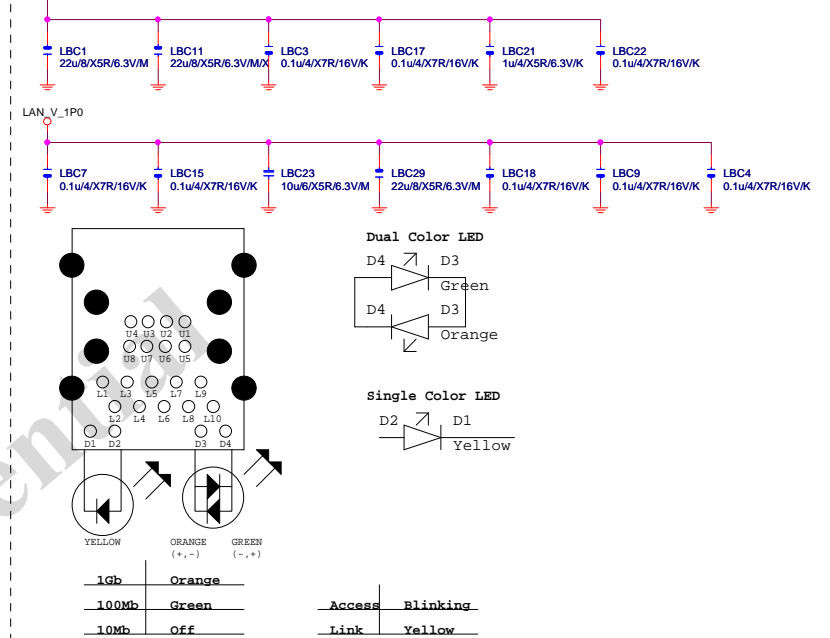
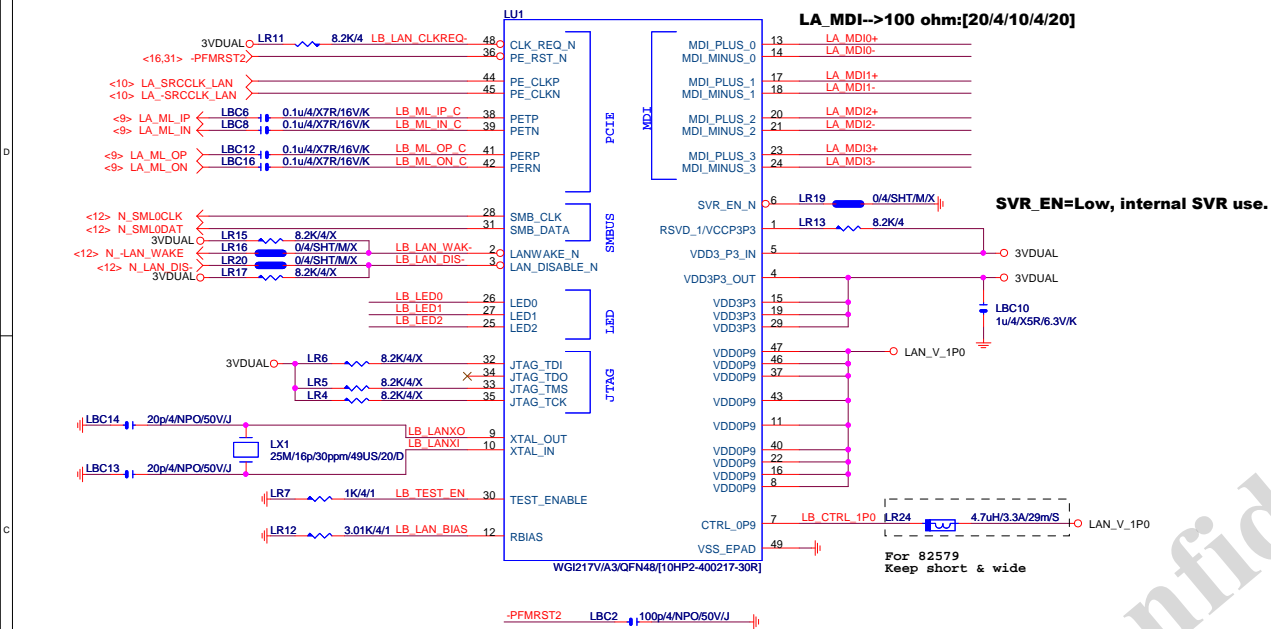


AZALIA FRONT PANEL



Gigabyte Technology

Title			
AUDIO JACK			
GA-H97M-DS3P			
Size	Document Number	Rev	1.0
Custom			
Date:	Tuesday, April 22, 2014	Sheet	22 of 31

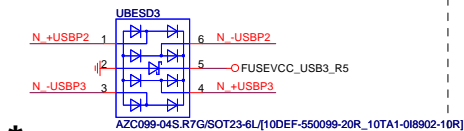


注意:USB PORT(目前:暫代6,7PORT)
USB-->90歐姆:[15/4.5/7.5/4.5/15]

BOM NOTICE *

料號	規格	廠商
11NR6-702009-96R	1G LAN (12core)	UDE(RU9 ESD+)
[LED獨立走線,可省略外加AZC099料件LAESD1]		

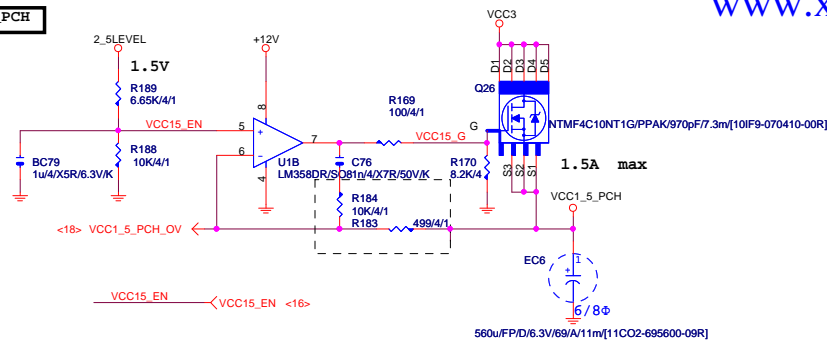
1. 9KV ESD BOM:
USB_LAN (RU9):11NR6-702009-96R
2. 28KV ESD BOM:
USB_LAN (RU9):11NR6-702009-96R
LAESD2, LAESD3: 上件AZC398-04S



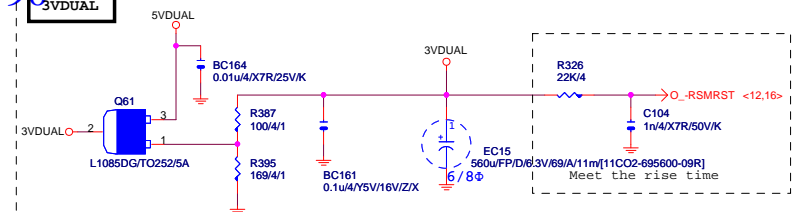
*** AZC099-04S.R7G/SOT23-6L/110DEF-550099**

使用RU9 USB_LAN可省略LAESD1保護LED

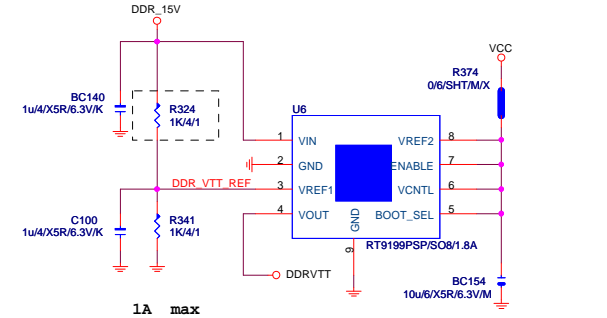
VCC1_5_PCH



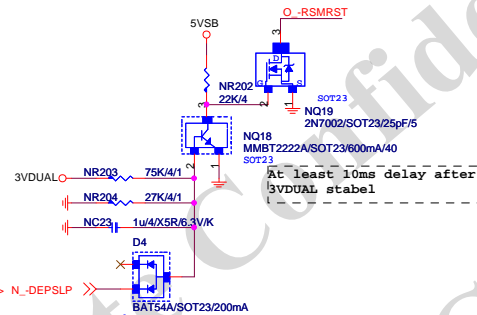
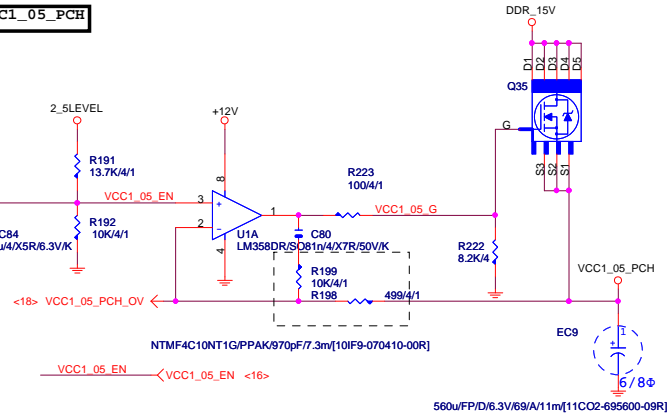
3VDUAL



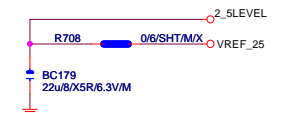
DDRVTT



VCC1_05_PCH



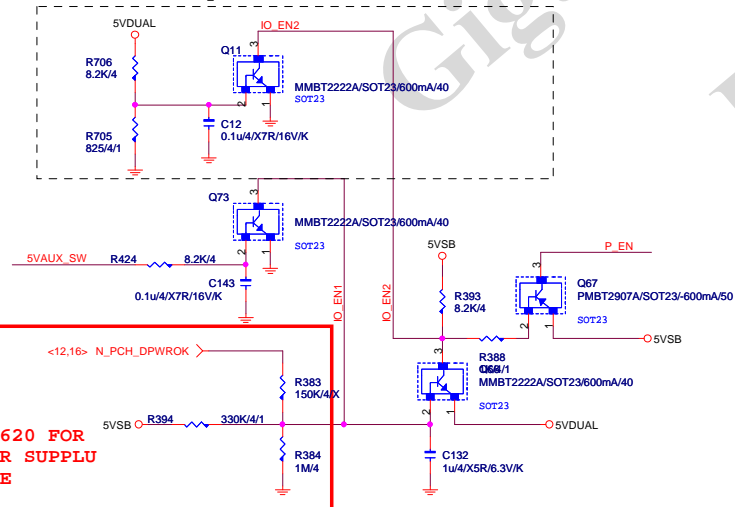
2_5LEVEL



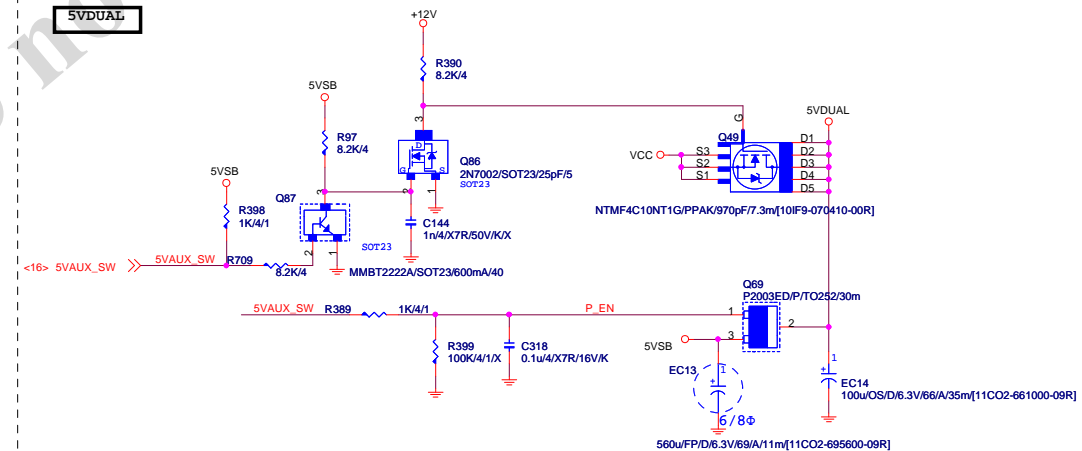
5VDUAL SHORT PROTECT

5V:0.40V
7.5V:0.602V
9V:0.722V

5VSB OVP:7.5V protection



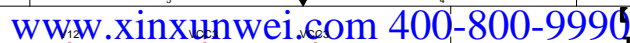
5VDUAL



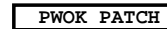
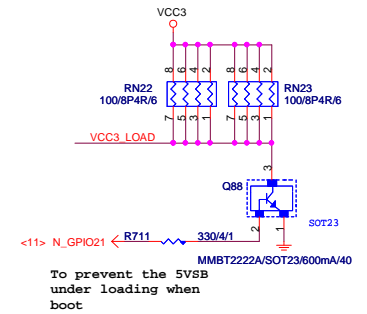
Gigabyte Technology

Title			
DISCRETE POWER			
Size	Document Number	Rev	
Custom	GA-H97M-DS3P	1.0	
Date:	Tuesday, April 22, 2014	Sheet	24 of 31

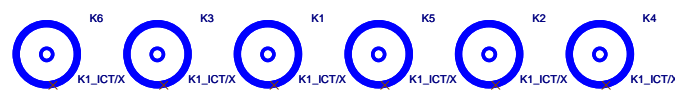
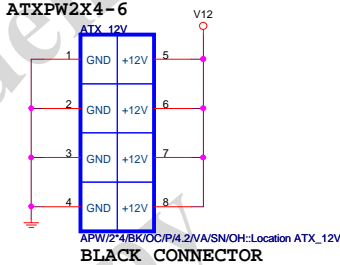
【技術通報R&D技術通報155】

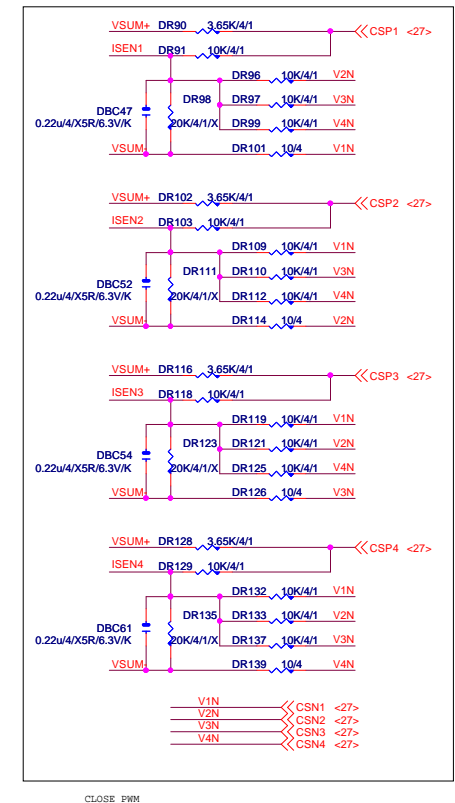
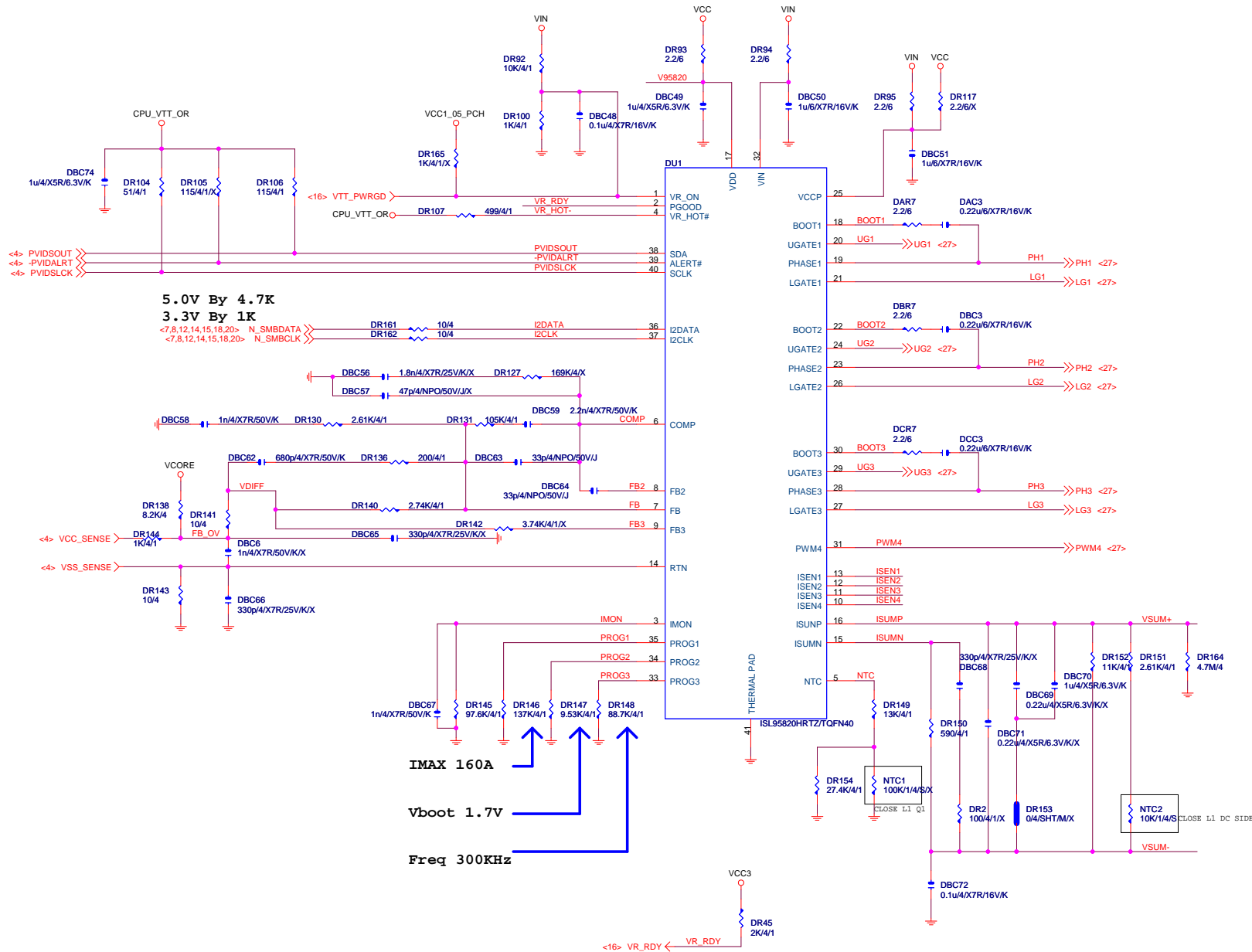


To fix 12V light load abnormal issue



ATXPW2X4-6

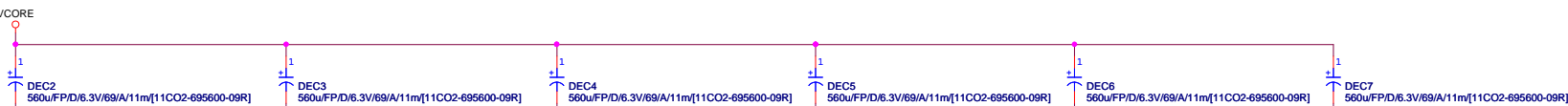
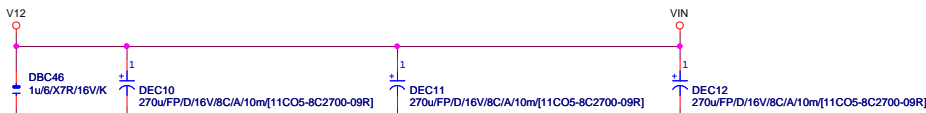
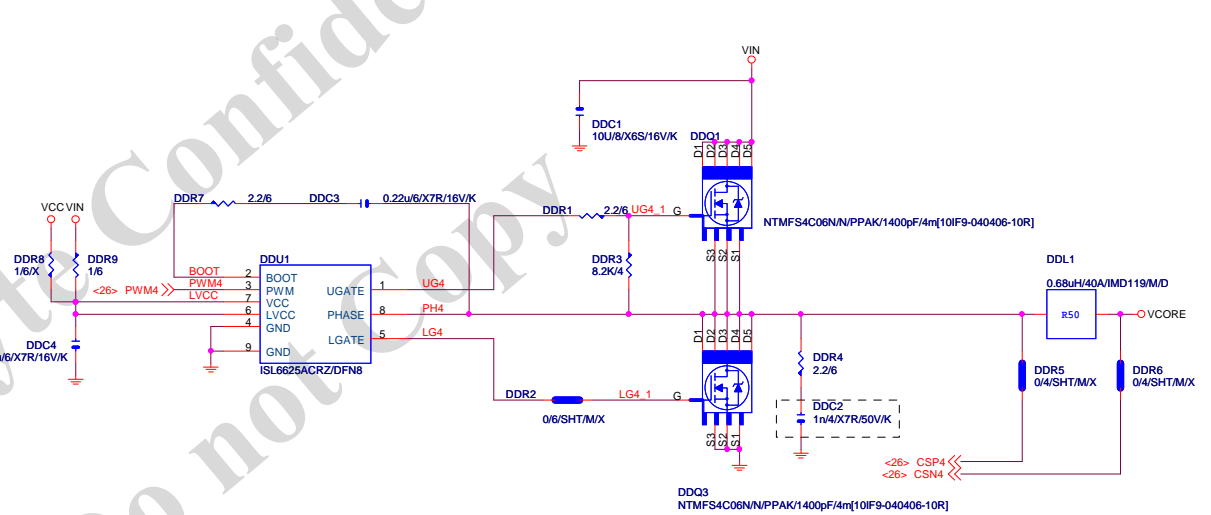
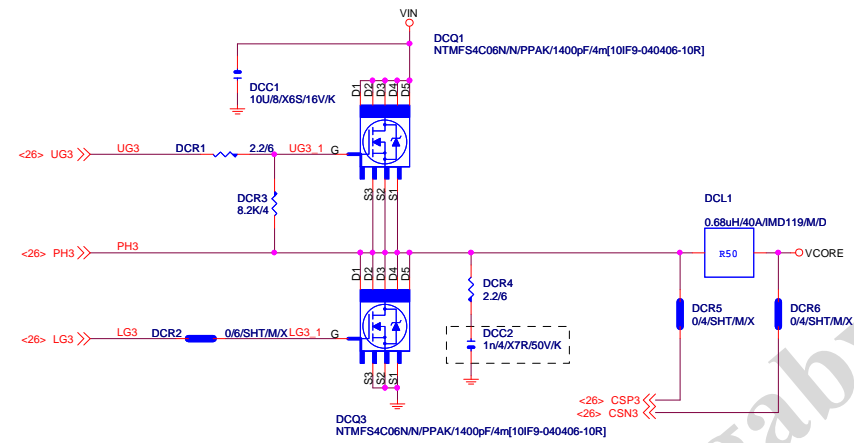
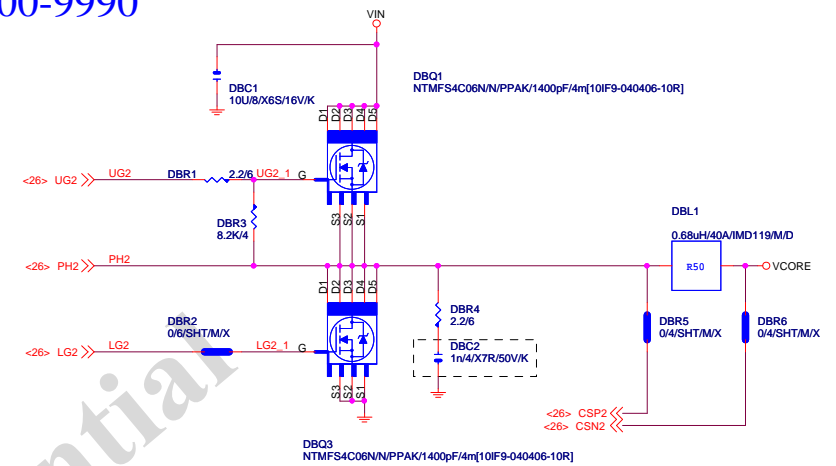
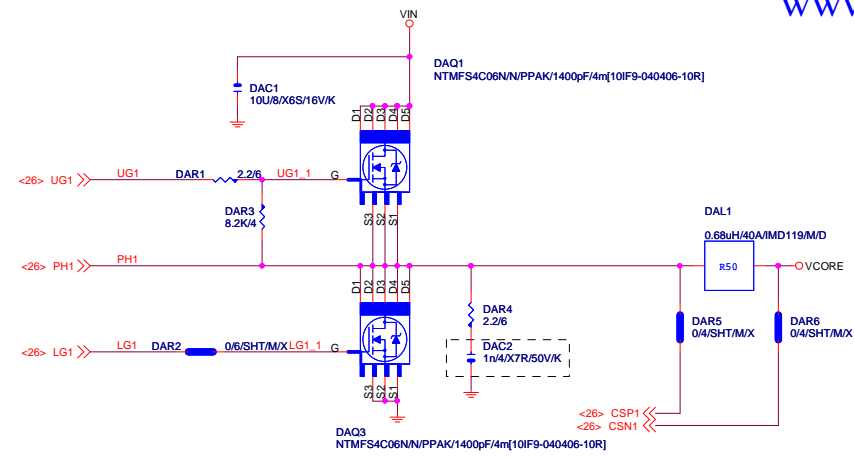


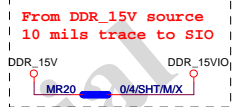


CLOSE PWM

Gigabyte Technology

Title			
CPU CORE VR-1			
Size	Document Number	GA-H97M-DS3P	
Custom			Rev 1.0
Date:	Tuesday, April 22, 2014	Sheet	26 of 31



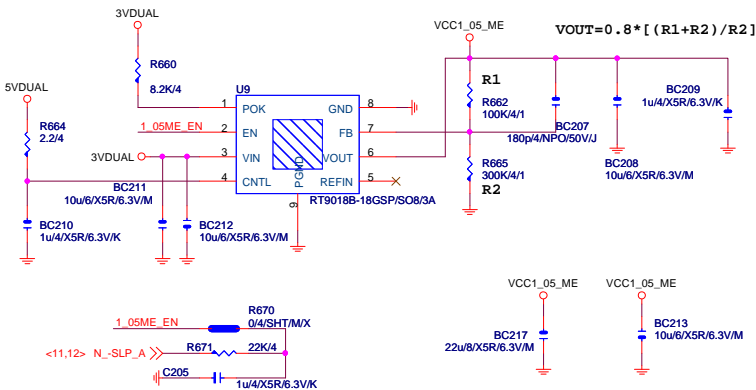


VIN=5V,VOUT=1.5V,IOUT=25A,PHASE=1
IRMS=11.45A
560u/FP/D/6.3V/68/8m RIPPLE CURRENT=4.7A
Coefficient=1.7(85°C),1(105°C)
VIN Ripple current=4.7X1.7=7.99A(85°C)
-->故固態電容須 $27.99 \geq 15.98 > 11.45A$

```
Rocset=(Iocp*Lgate,rdson)/Iocset
Rocset=(45A*6.7mOhm)/10uA = 30K
Iocset=10uA
```

VCC1_05_ME

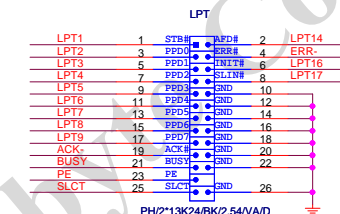
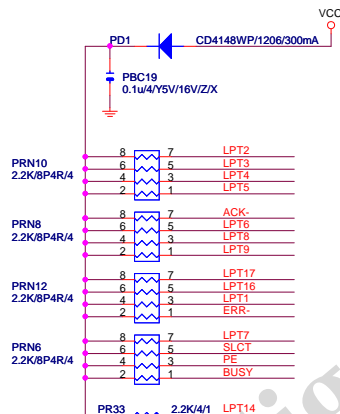
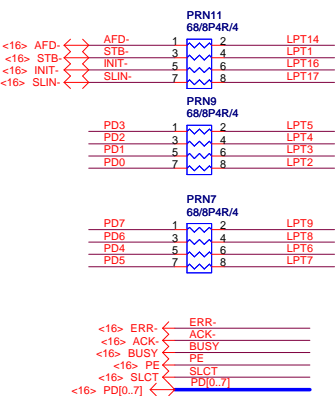
【技術通報R&D技術通報156】
(RICHTEK), (NUVOTON), (EMC)做共用
PIN7分壓阻值須做修改為100K以上電阻值



Second source
EM5103 - 10GL2-305103-01R
NCT3730S -
10GL2-303730-01R

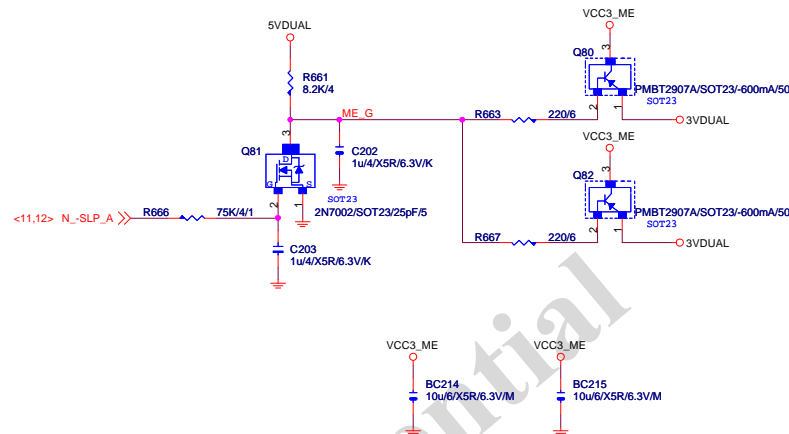
LPT PORT

【技術通報R&D技術通報151】
33ohm Change to 68ohm

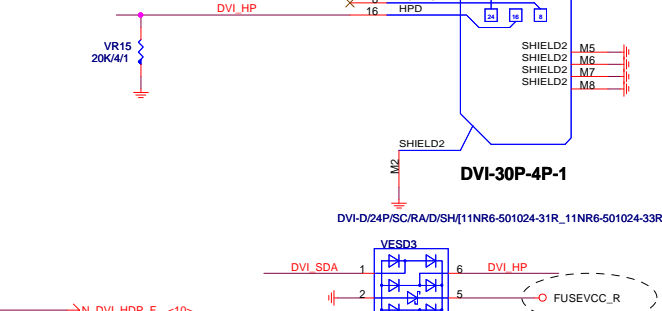
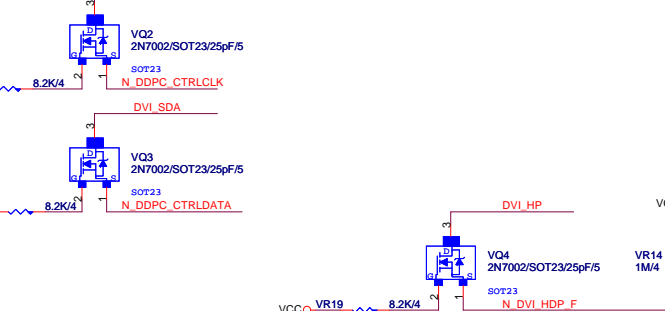
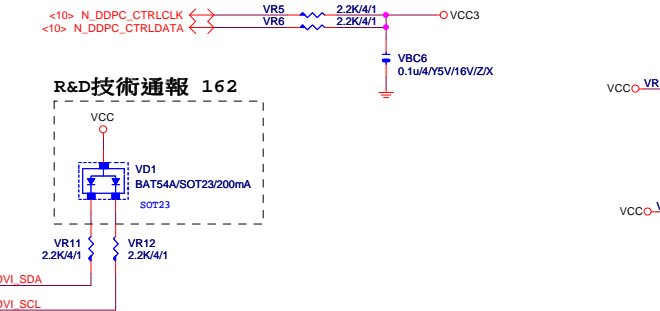
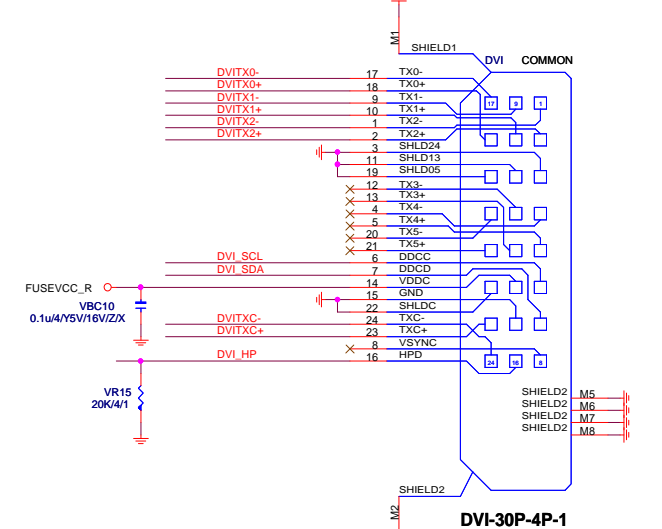
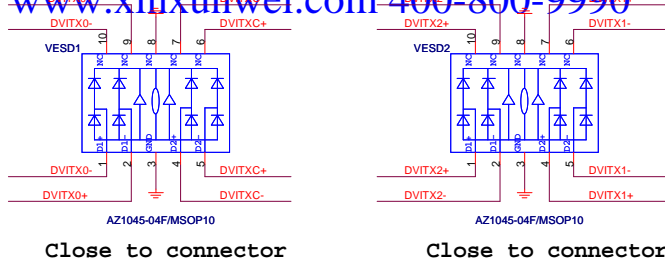
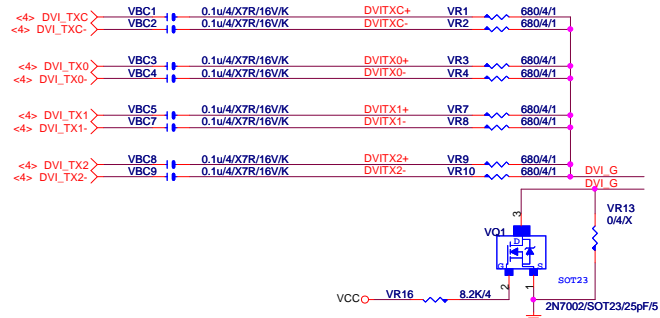


www.xinxiunwei.com 400-800-9990

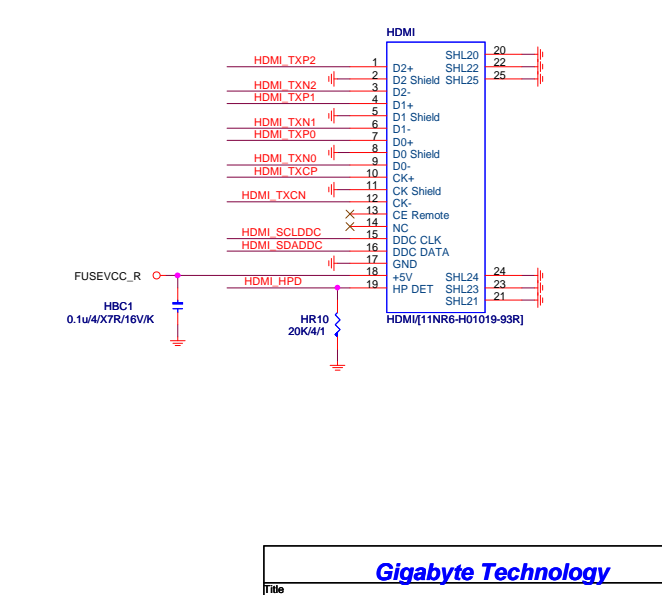
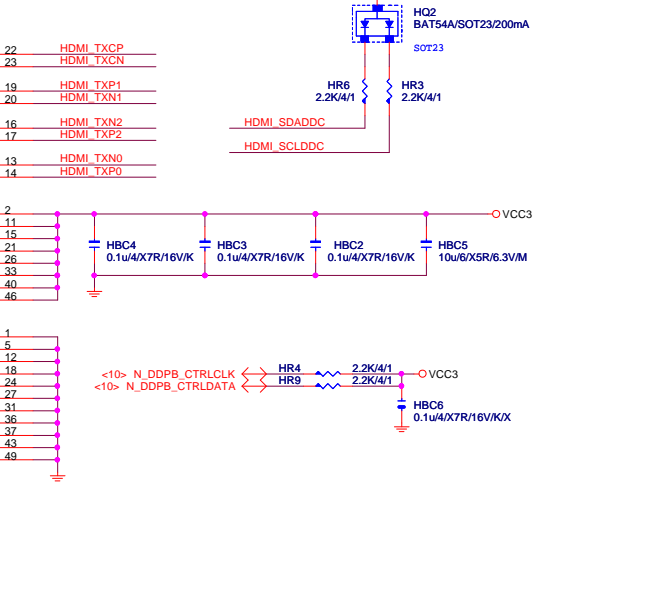
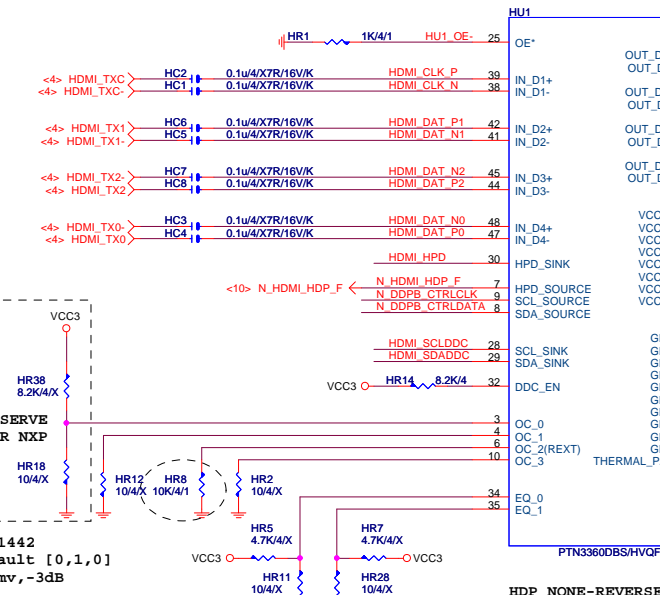
VCC3_ME



DVI



HDMI LEVEL SHIFT



Gigabyte Technology			
DVI			
GA-H97M-DS3P			
Size	Document Number	Rev	
Custom		1.0	
Date:	Tuesday, April 22, 2014	Sheet	30 of 31

